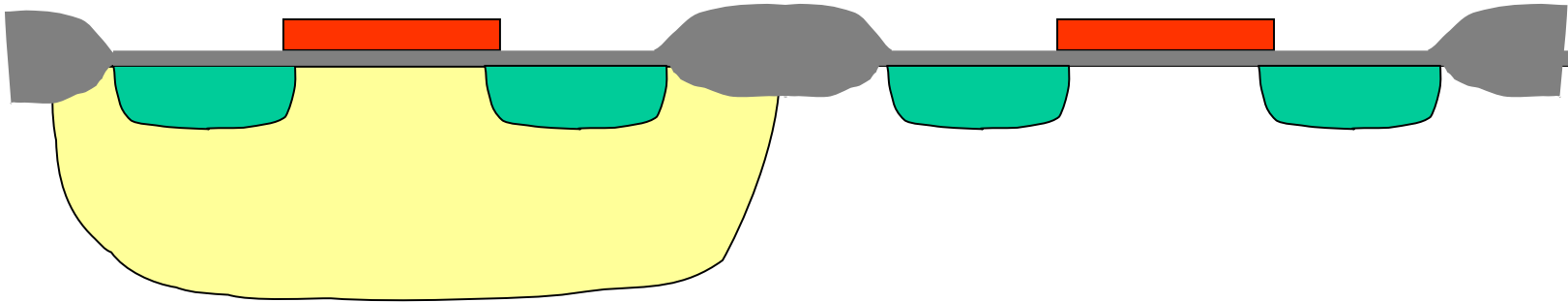


MOS transistors (in subthreshold)

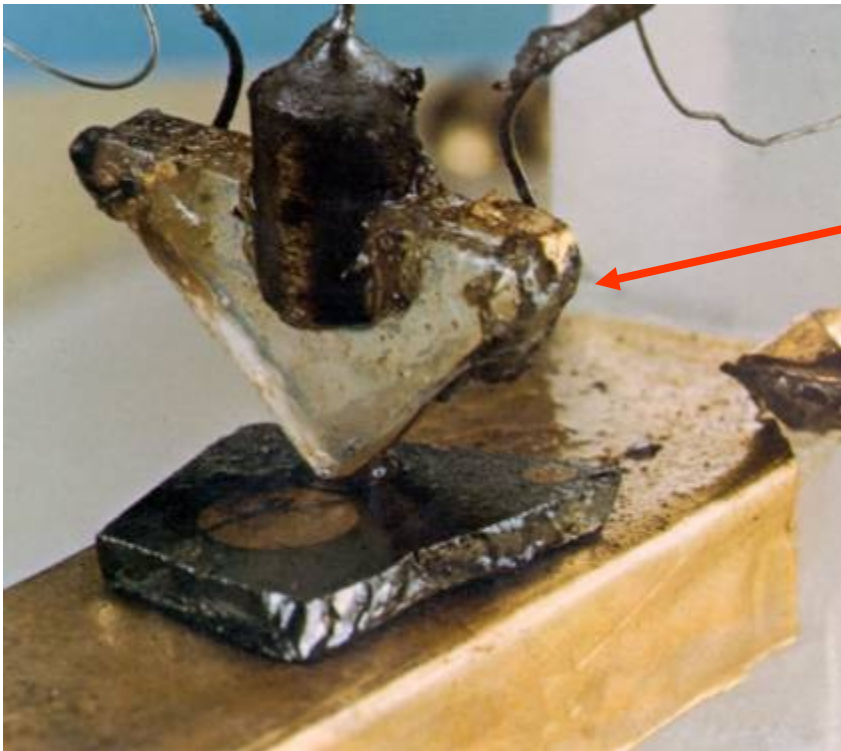


- History of MOSFET
- Review of Semiconductors
- What is a MOSFET? CMOS?
- How physics of transistors and voltage-sensitive nerve membrane channels are related
- MOS capacitor structure
- Surface: accumulation, depletion, inversion
- Capacitive dividers: The back-gate/body effect parameter κ
- MOS transistor in subthreshold

History of the Transistor

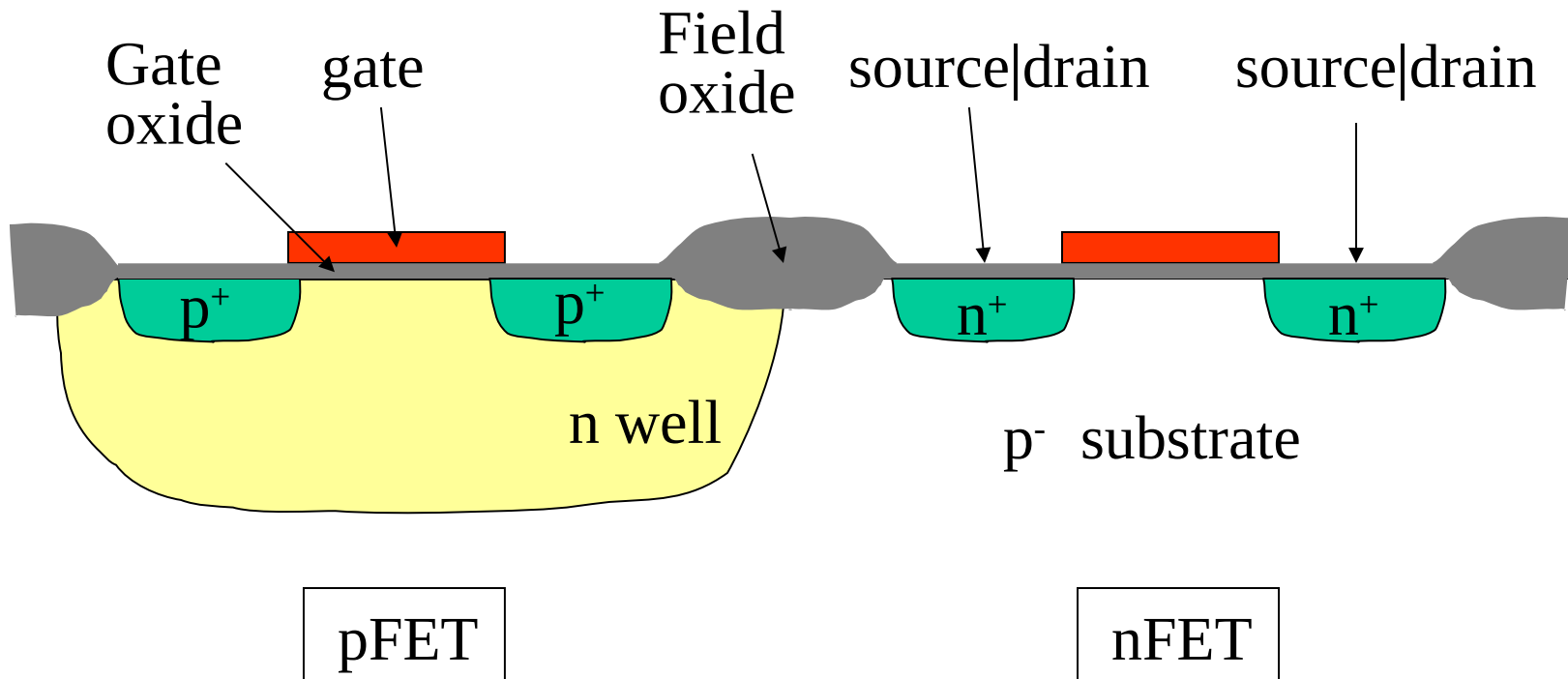
The term “transistor” is a generic name for a solid-state device with 3 or more terminals.

The field-effect transistor structure was first described in a patent by J. Lilienfeld in the 1930s! It took about 40 years before MOS transistors were in mass production.

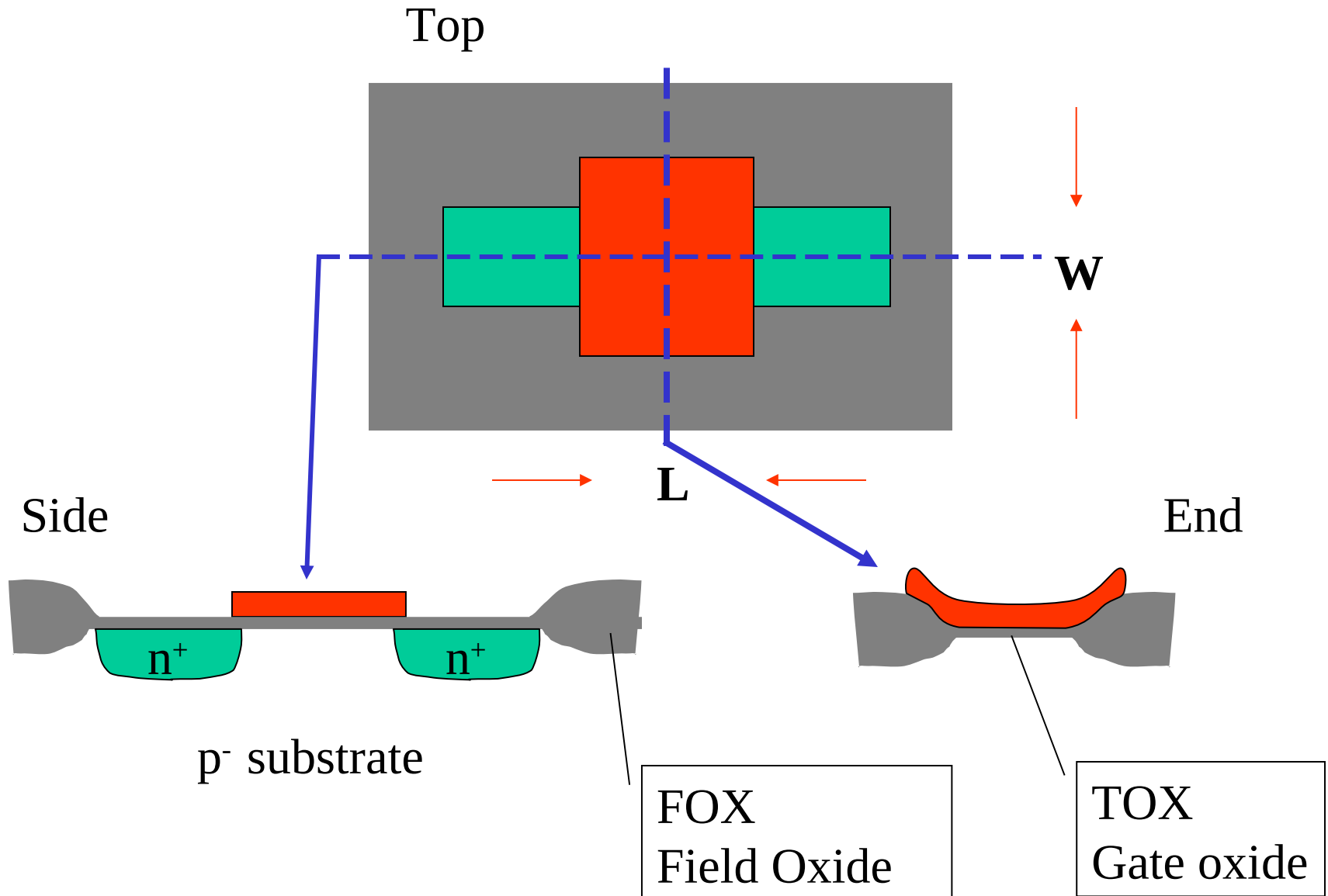


The first transistor
(point-contact bipolar)
fabricated at Bell Labs in 1947
(Bardeen, Brattain, Shockley).
MOS transistors were not
commercialized until mid
1970's.

Cross-section of a complementary pair of Field-Effect Transistor (FET)

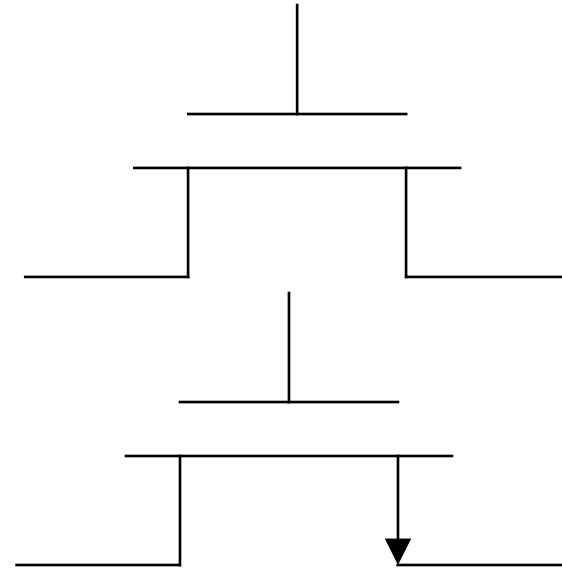
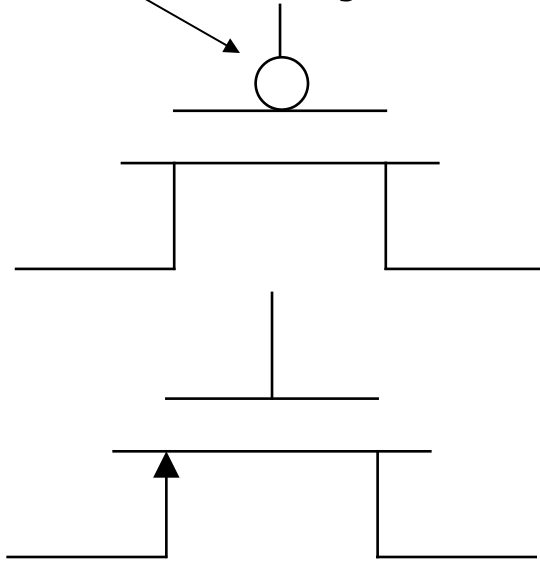


Top and Side Views of Field-Effect Transistor (FET)



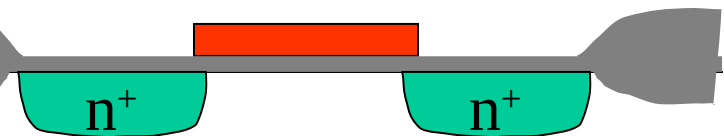
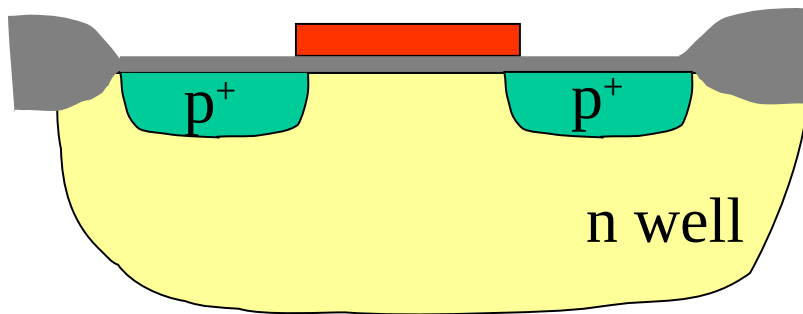
hole carriers

Symbols for transistors



pn junction & source

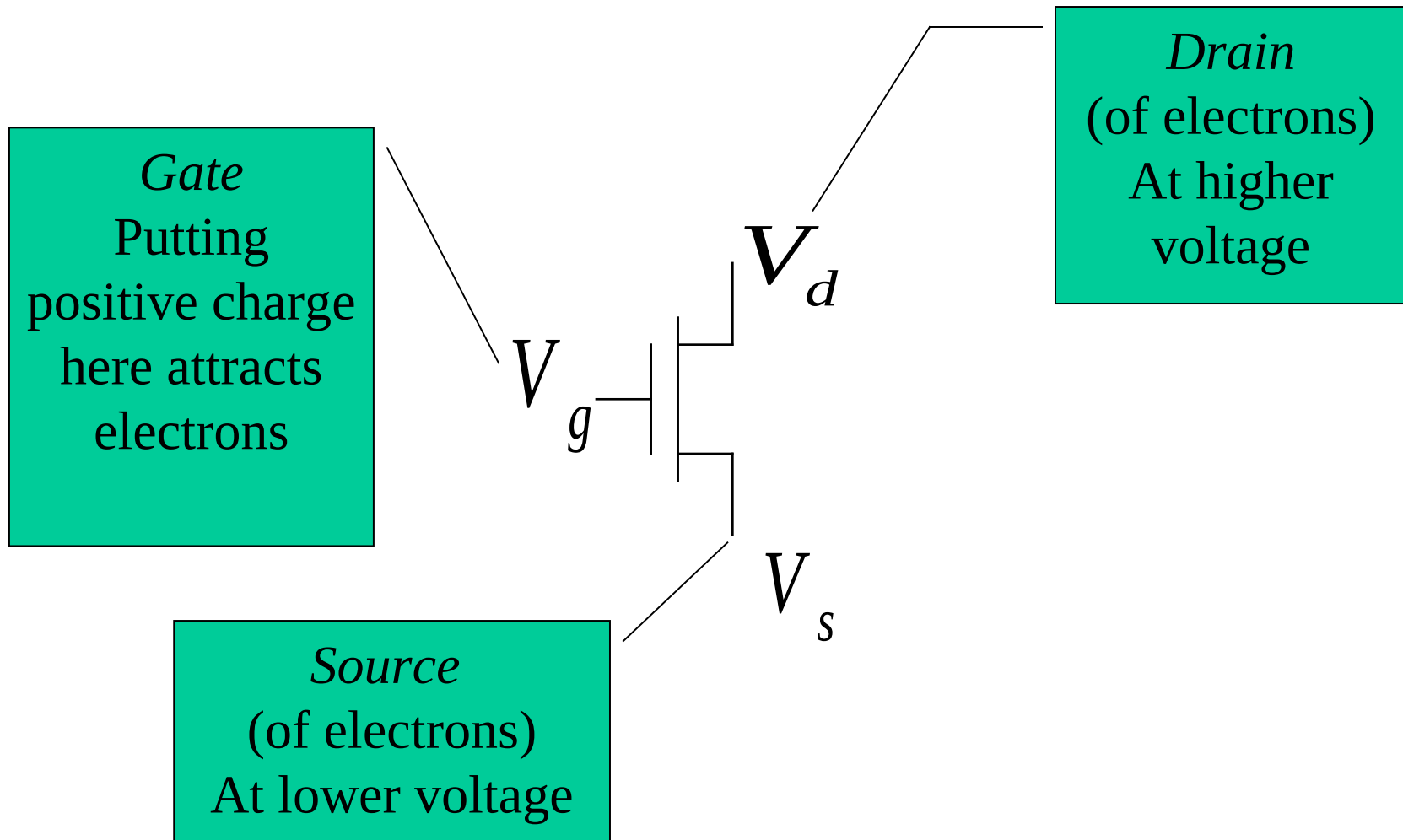
pn junction and source



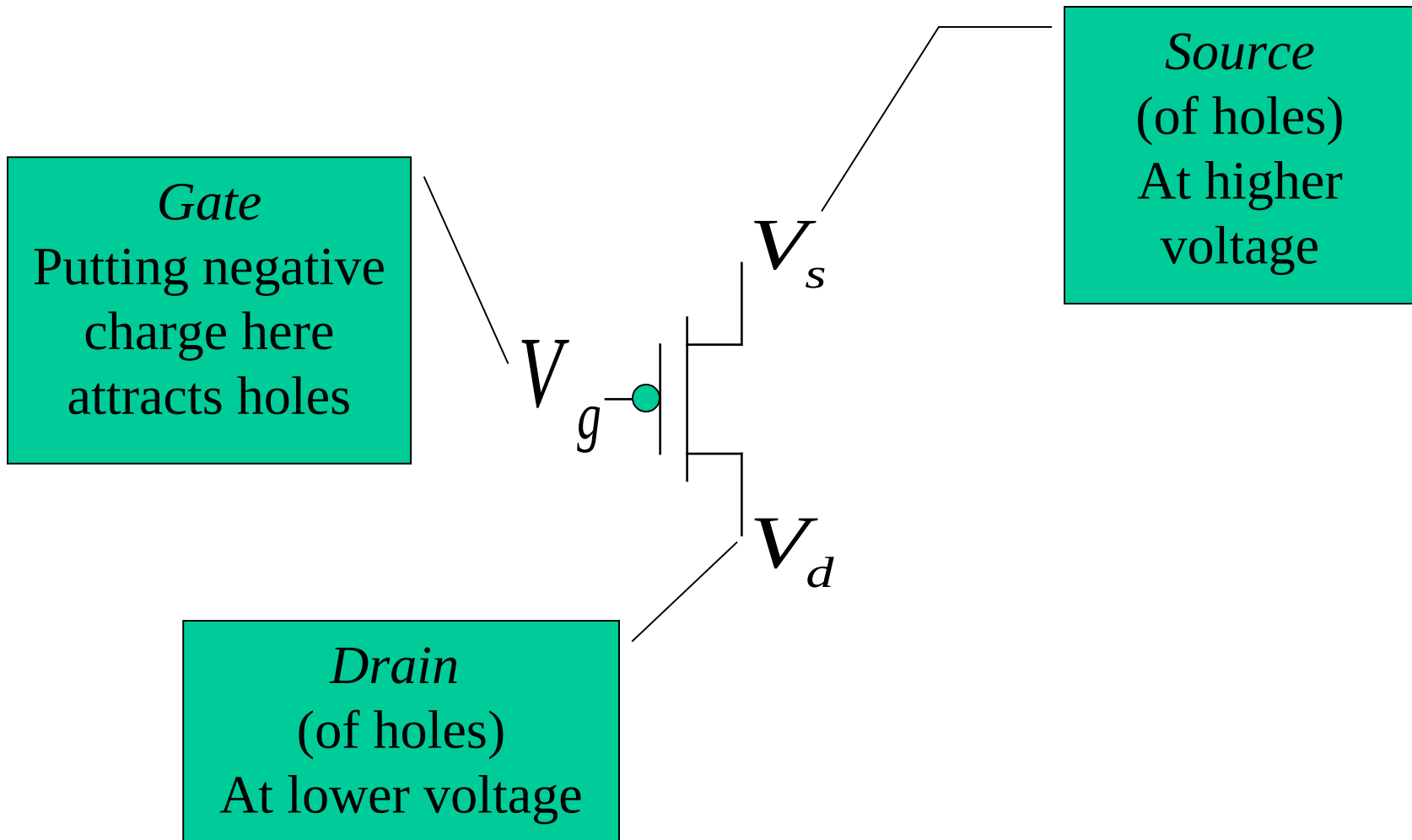
pFET

nFET

nFET terminology



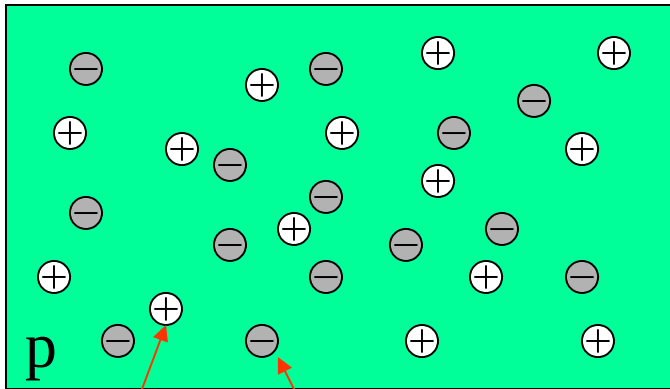
pFET terminology



Review on Semiconductors

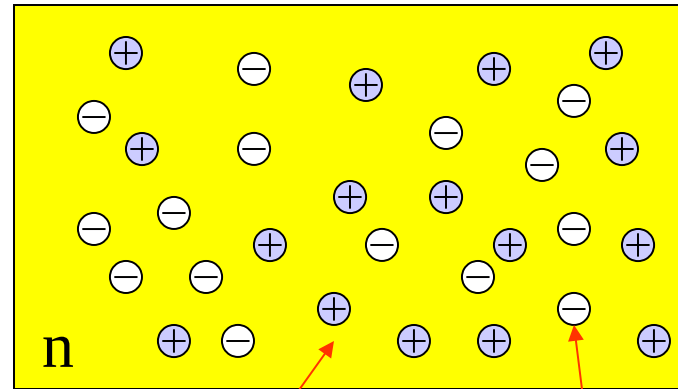
Intrinsic silicon is undoped

Extrinsic silicon is doped



holes

ionized acceptor



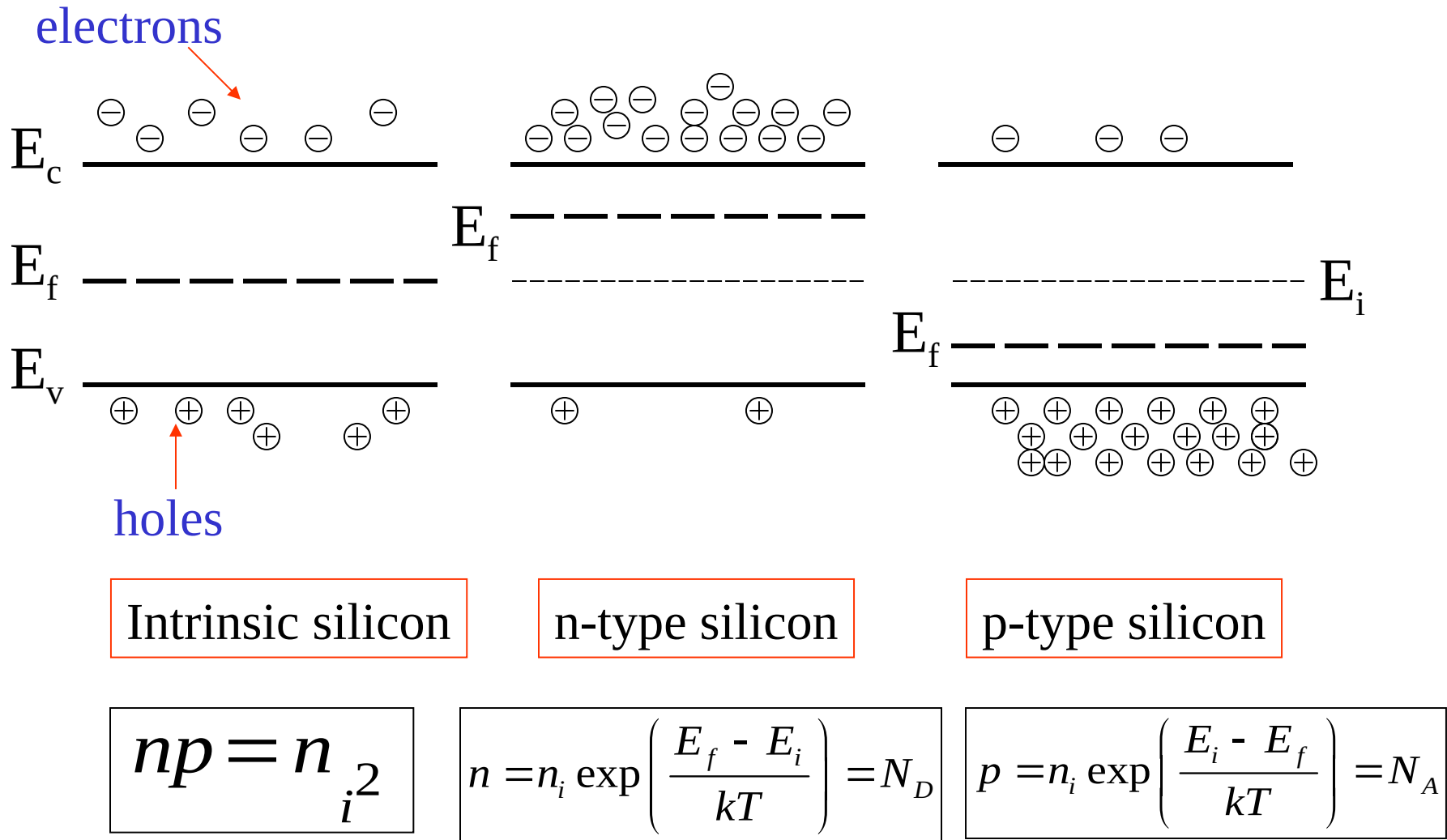
ionized donor

electrons

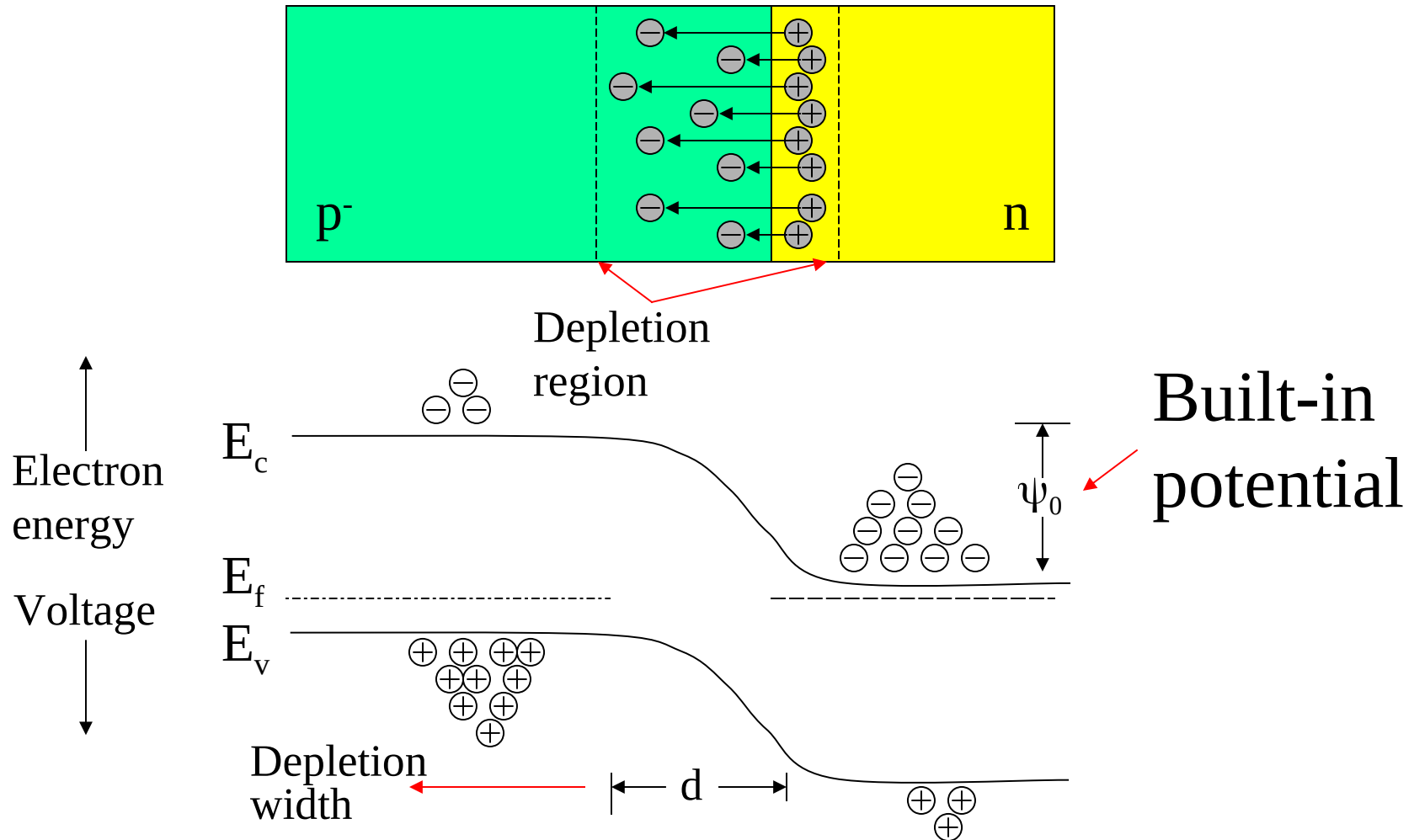
Majority carriers are holes
Minority carriers are electrons

Majority carriers are electrons
Minority carriers are holes

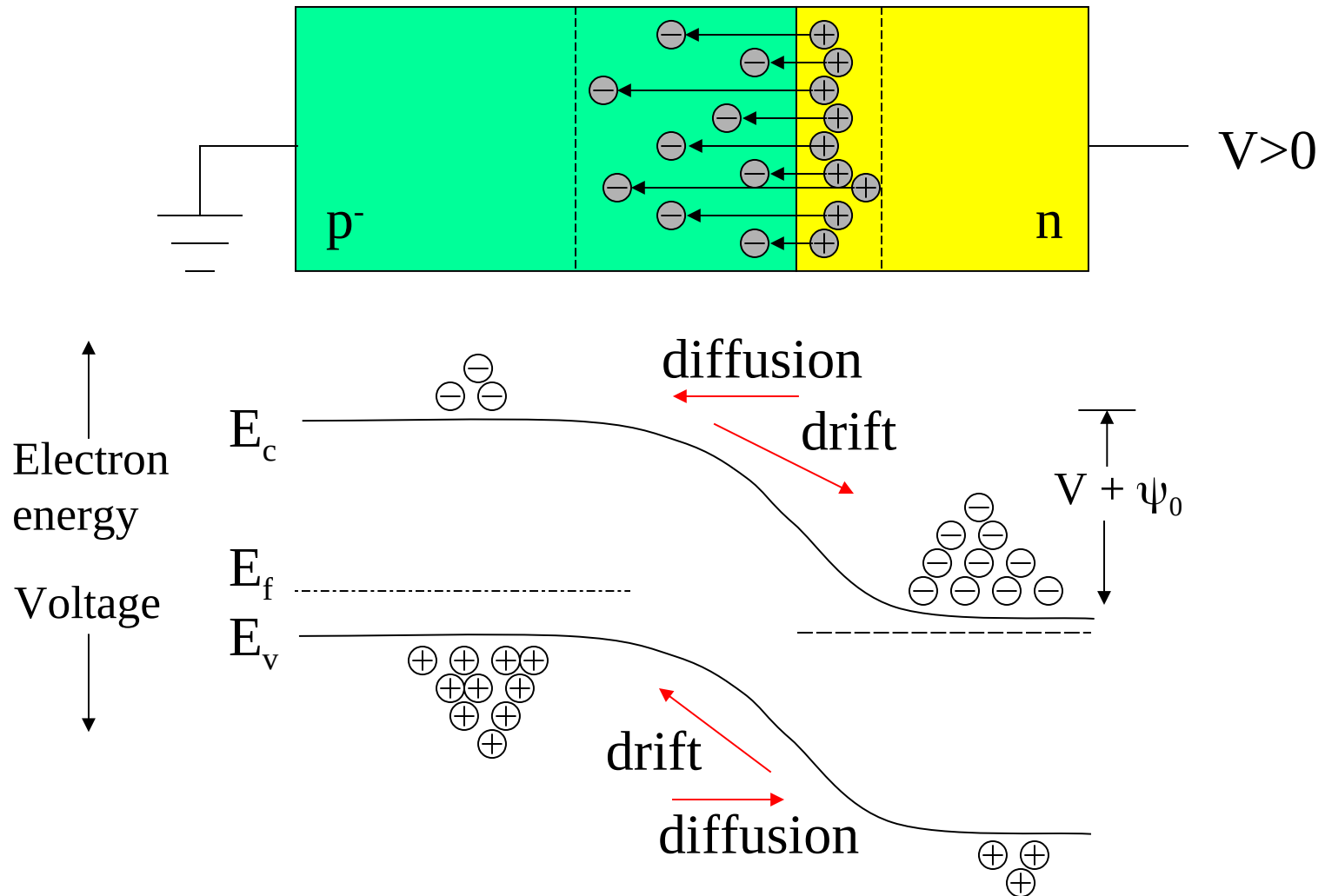
Review on Energy Band Diagrams



Equilibrium in a p-n Junction

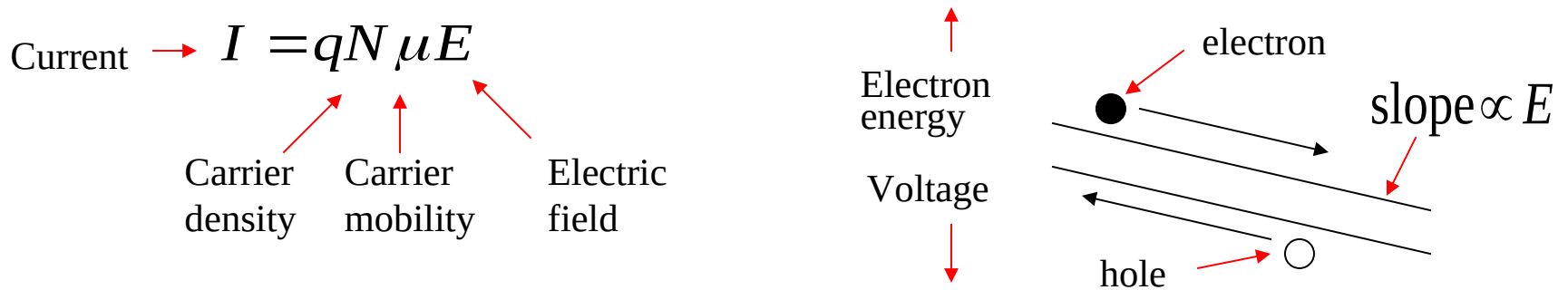


Reverse-biased p-n Junction

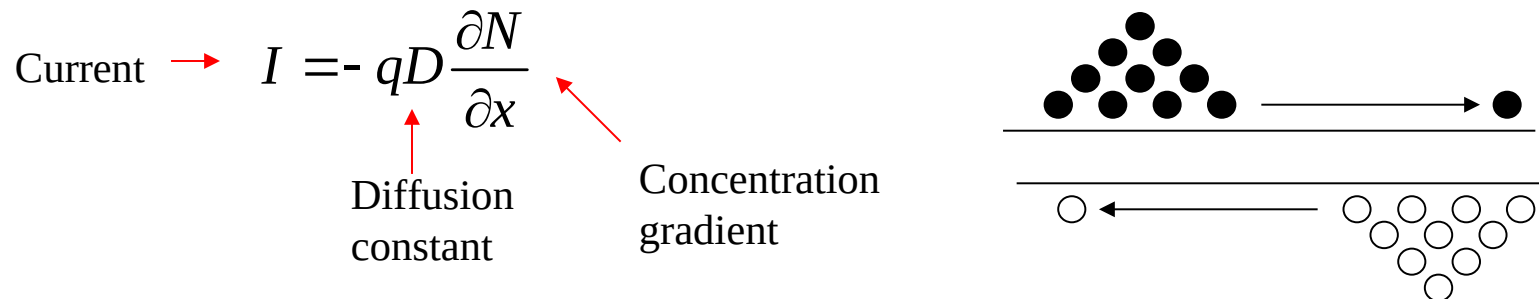


Mechanisms of Carrier Transport

Drift: Movement of charge carriers due to an external field



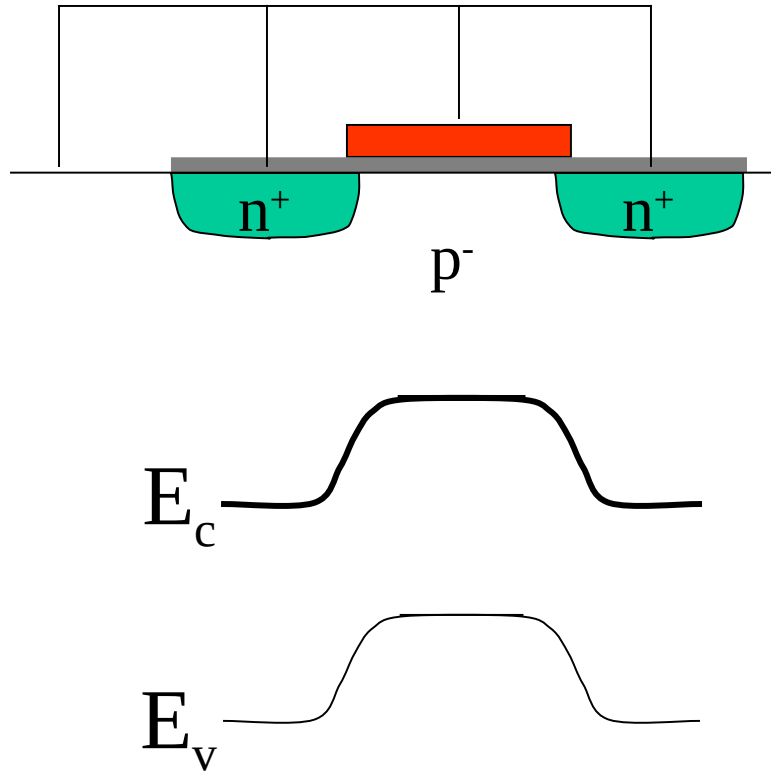
Diffusion: Movement of carriers due to a concentration gradient

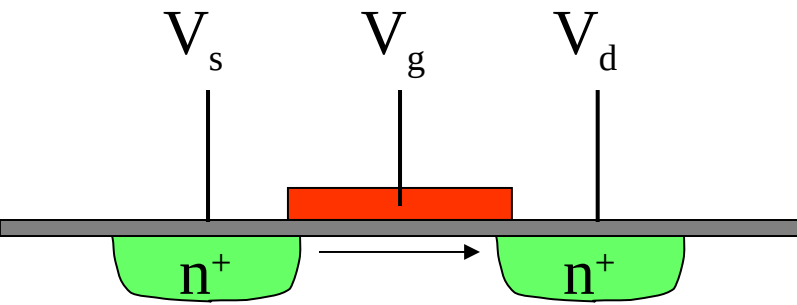


Einstein relation:

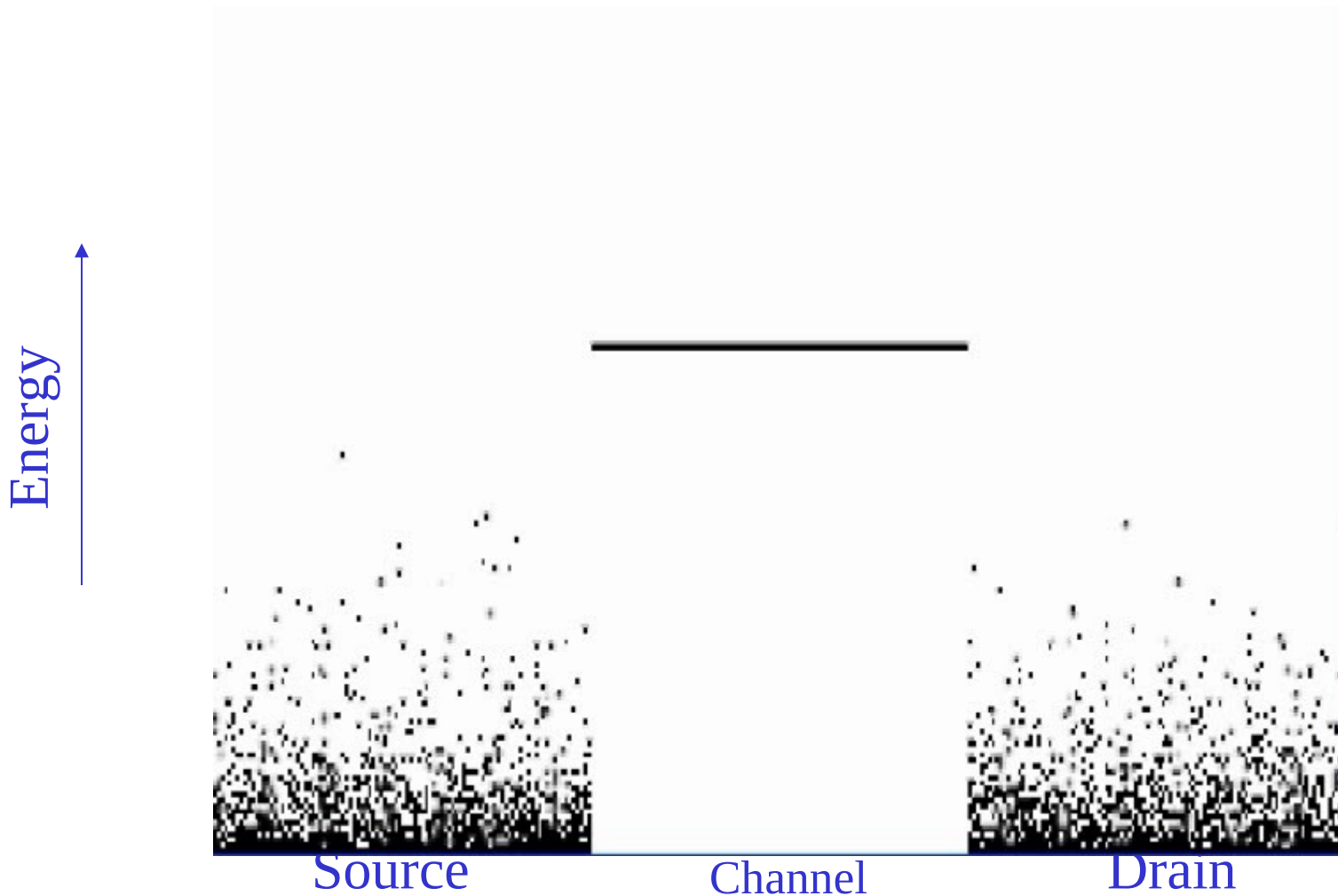
$$D = \frac{kT}{q} \mu$$

The built-in potentials in the pn junctions create an *energy barrier*. Controlling the barrier height controls the diffusion current.

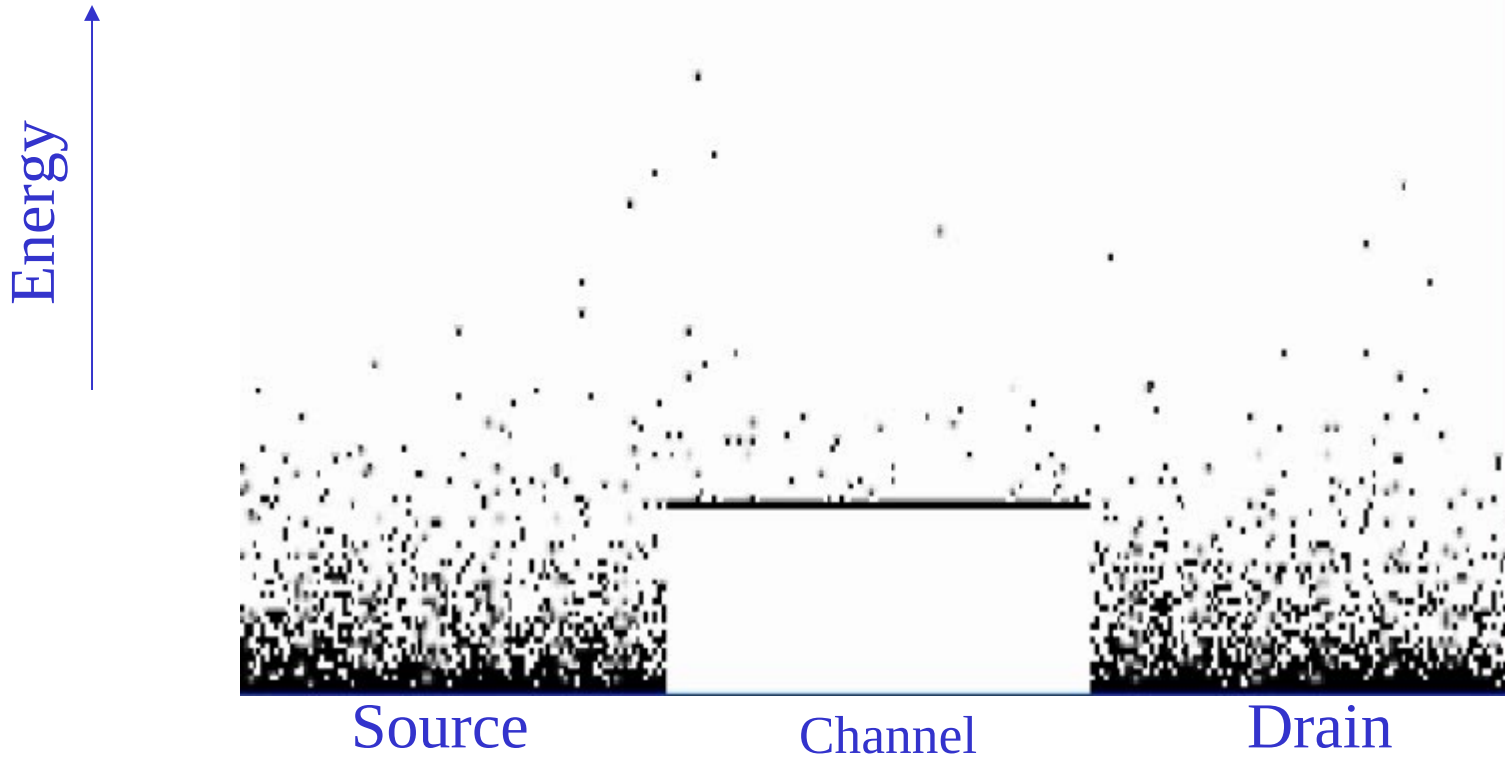
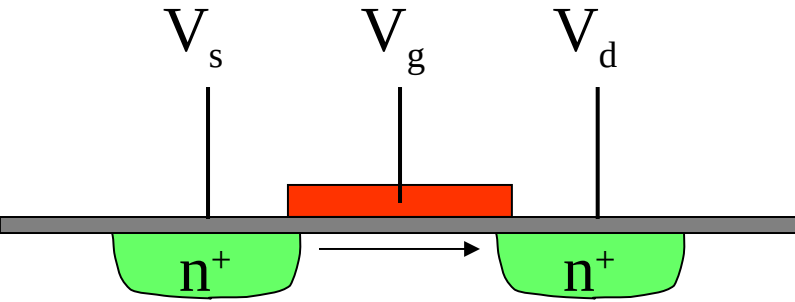




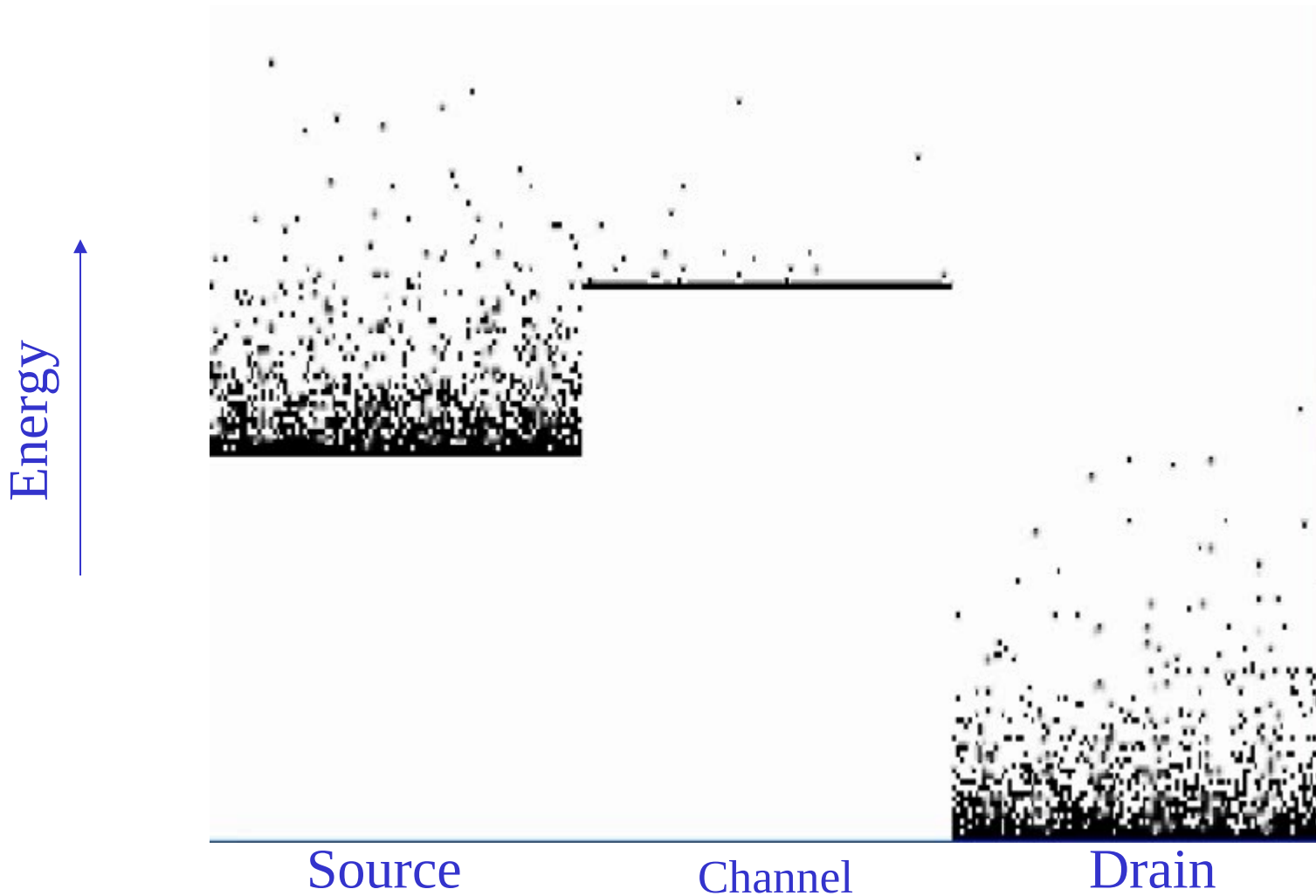
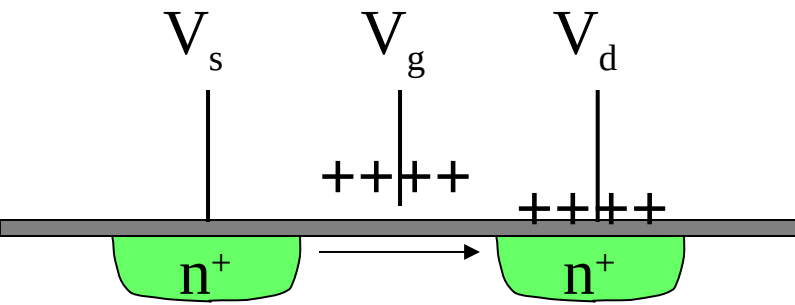
Small V_g s, $V_{ds}=0$



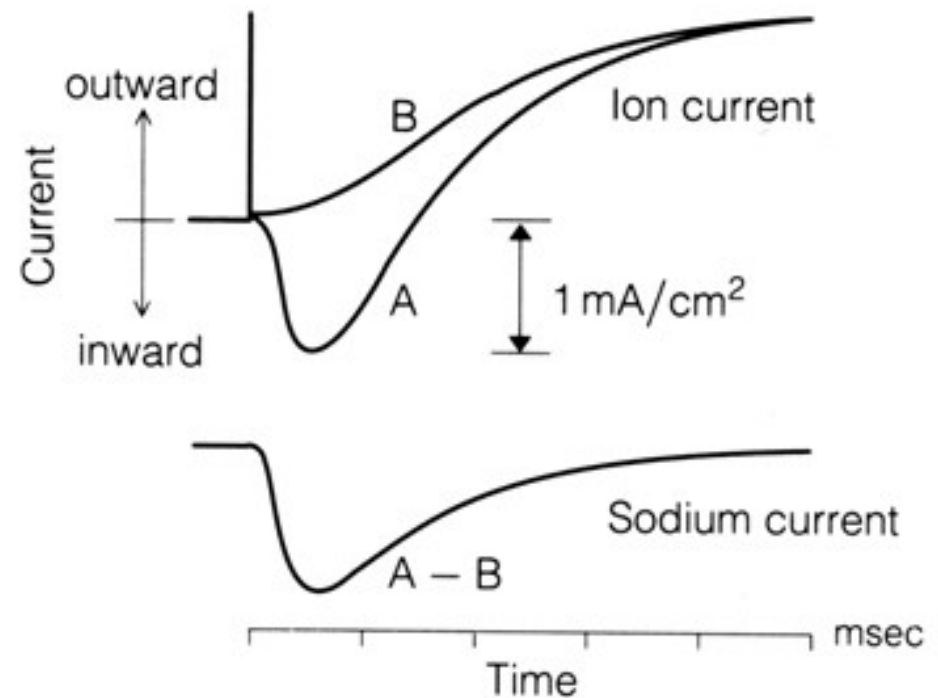
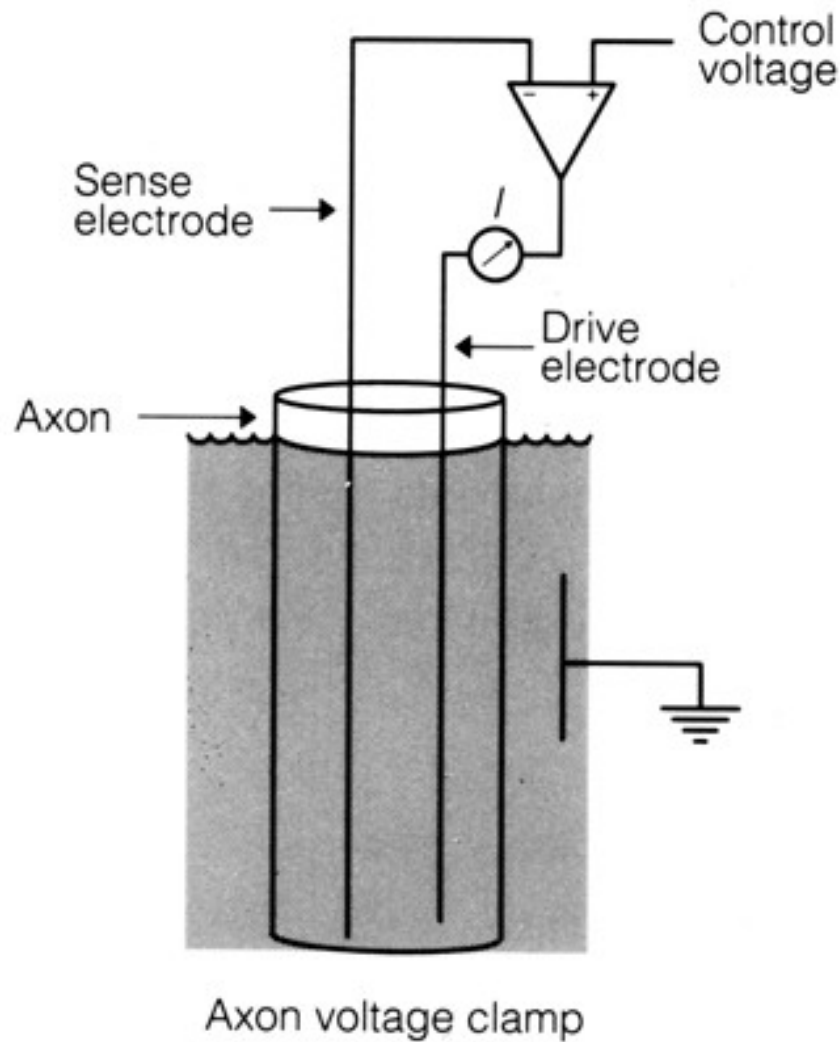
Larger V_{gs} , $V_{ds}=0$



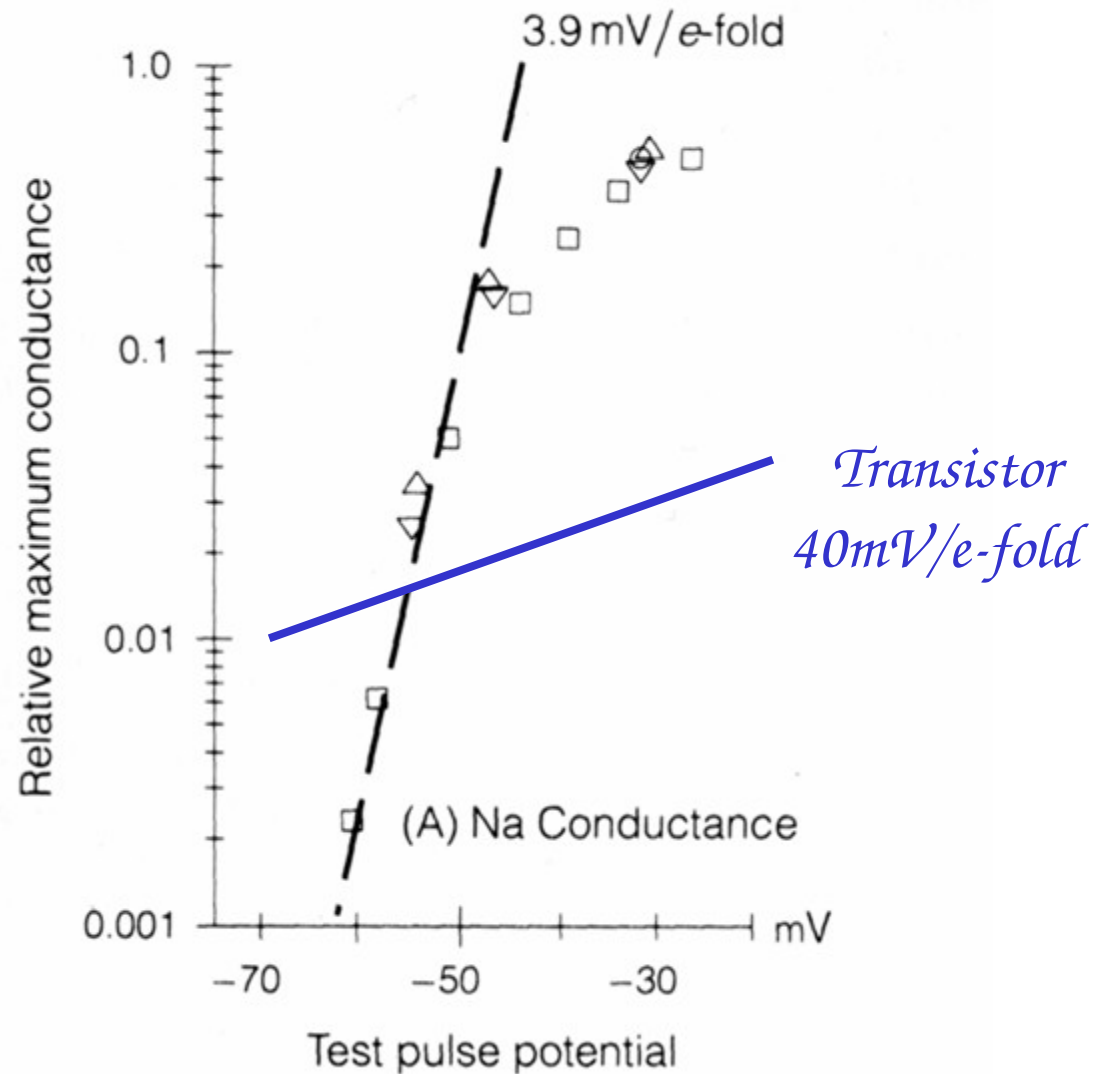
Larger V_g ,
Large V_d



Measuring voltage-dependent nerve membrane currents



Comparing transistor and membrane channel currents



Neuron channels and Transistors

Both depend on Boltzmann distributions.

Neurons

- Membrane ionic conductance is exponentially dependent on the voltage across the neuron membrane.
- The **population of open channels** depends exponentially on potential across barrier.

Transistors

- Current flow in transistors is exponentially dependent on barrier height.
- The **population of carriers** depends exponentially on the barrier height.

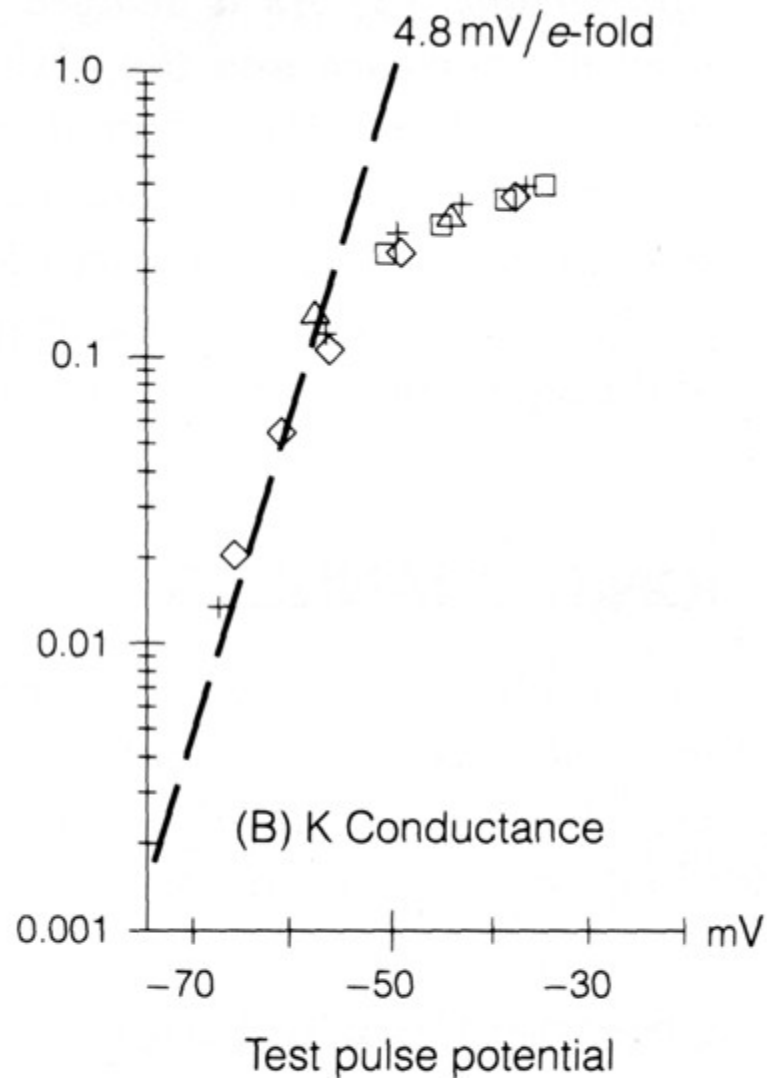
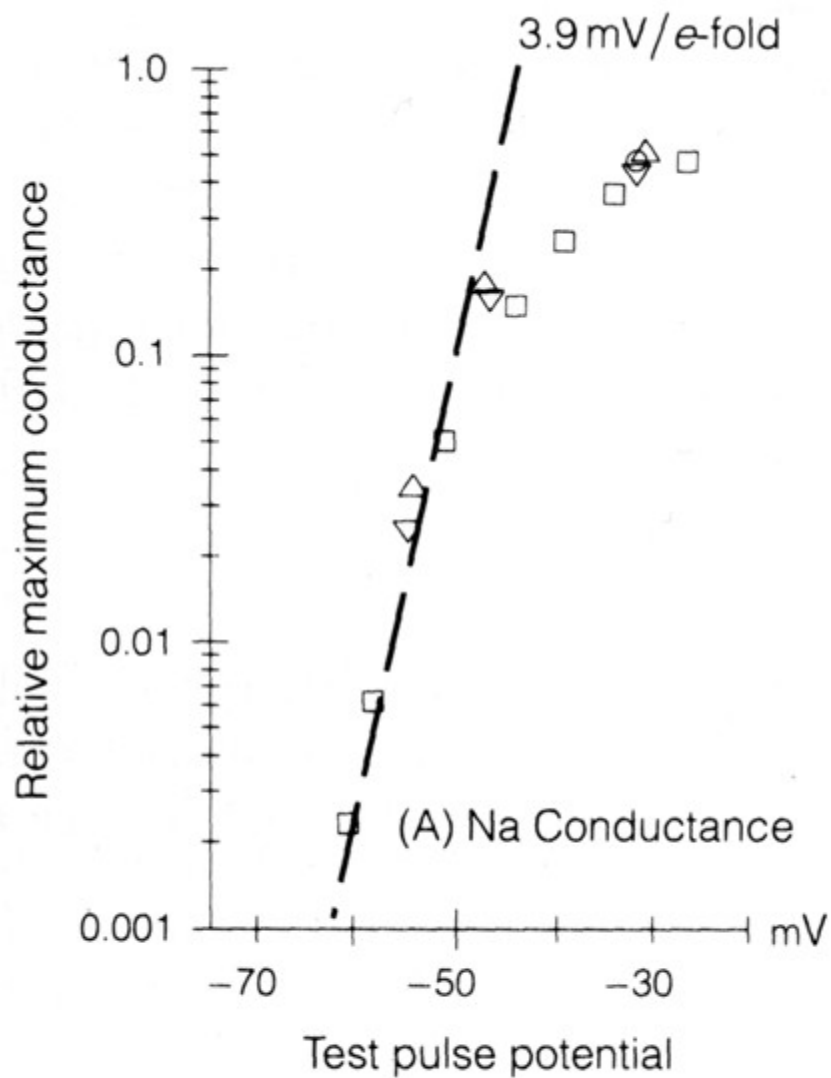
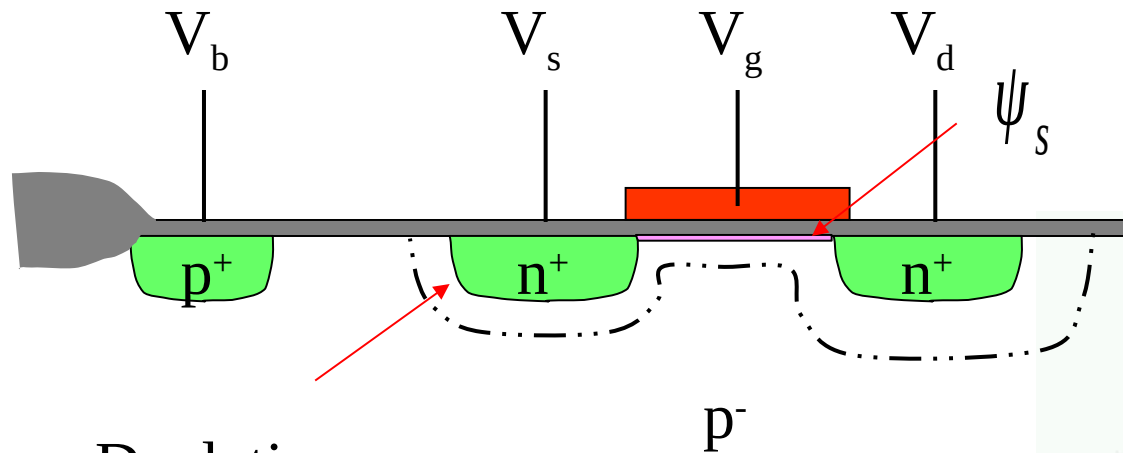


FIGURE 4.6 Exponential current–voltage characteristic of voltage-dependent channels. At high voltages, the fraction of channels that are open approaches unity, causing a saturation of the curves. (Source: [Hodgkin et al., 1952b, p. 464].)

n-type MOSFET

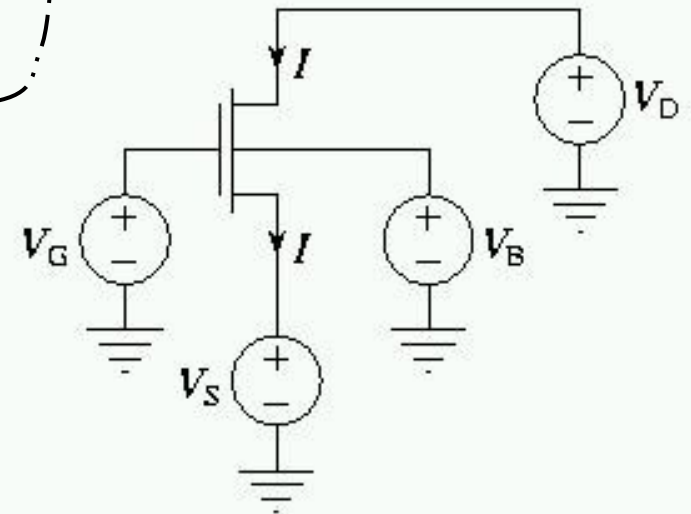
Bulk (back gate) source gate drain



Depletion
region

All voltages are referenced to $V_b = 0V$

$$V_s \geq 0V$$
$$V_g, V_d \geq V_s$$



Regimes of operation for FET (dependent on V_{gs})

- Cutoff - Surface is accumulated

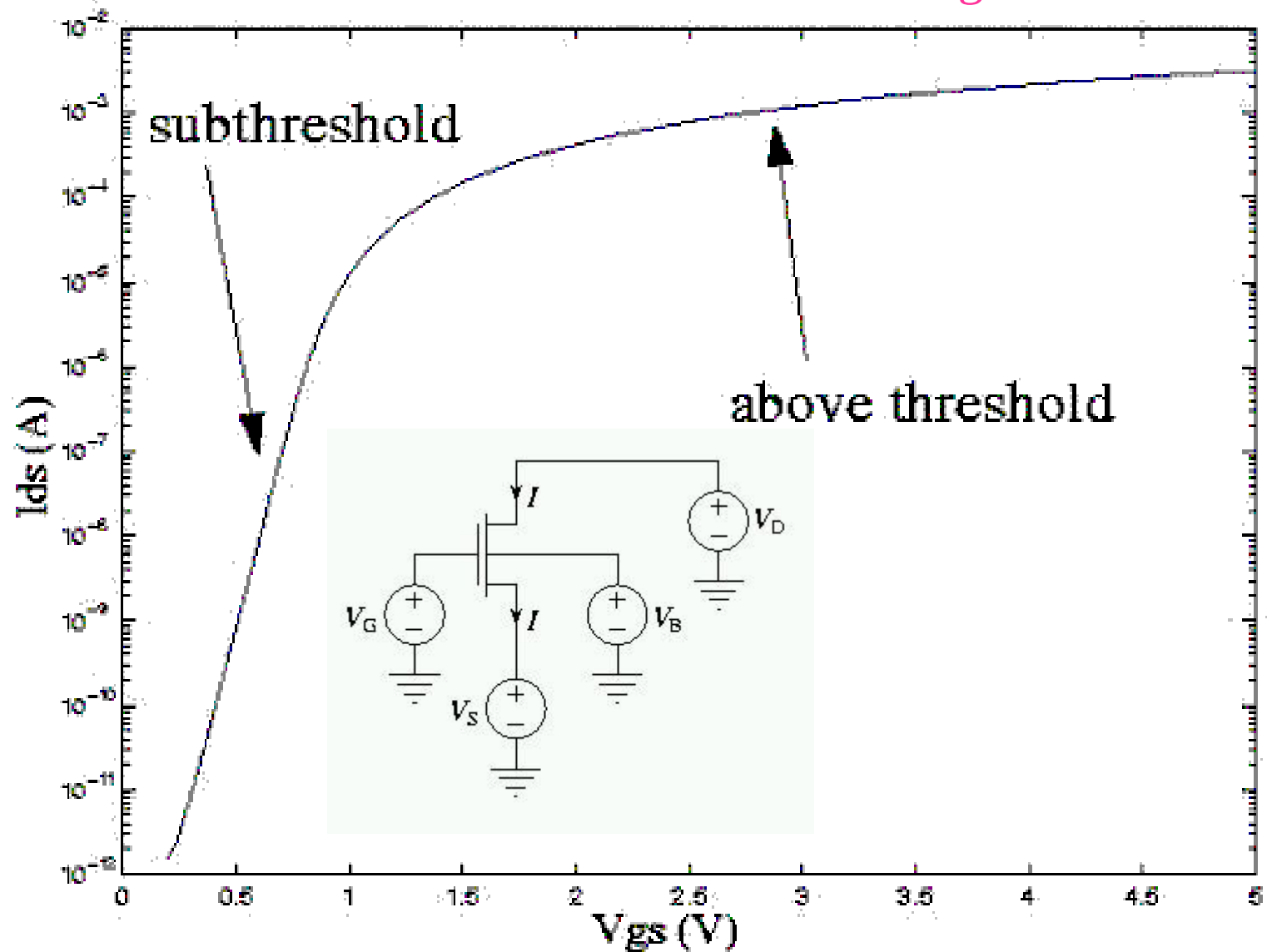
- Subthreshold (Weak Inversion) Regime

Current flows through diffusion

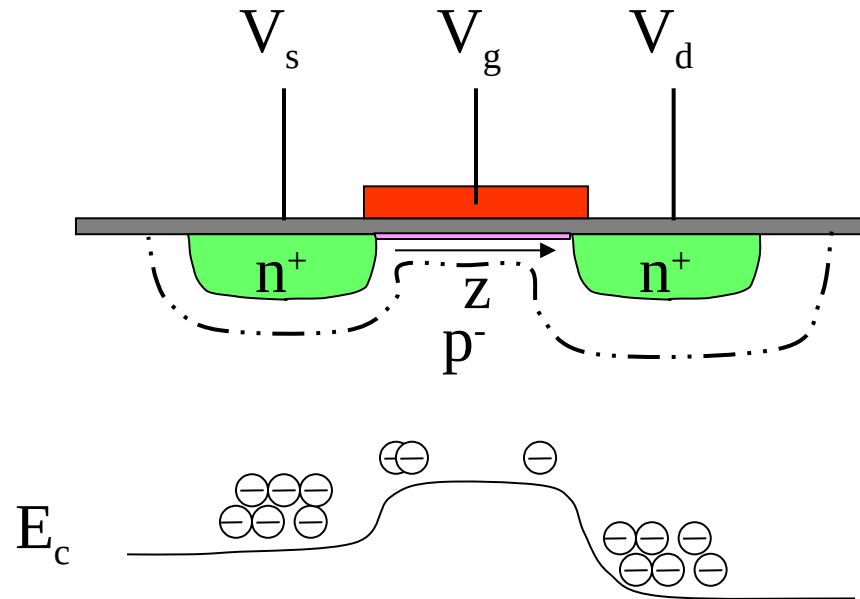
- Above threshold (Strong Inversion) Regime

Current flows through drift

nFet curve: I vs. V_{gs}



Subthreshold nFET: Current is diffusion current



$$I = -qD \frac{dN}{dz}$$

Current

Diffusion
constant

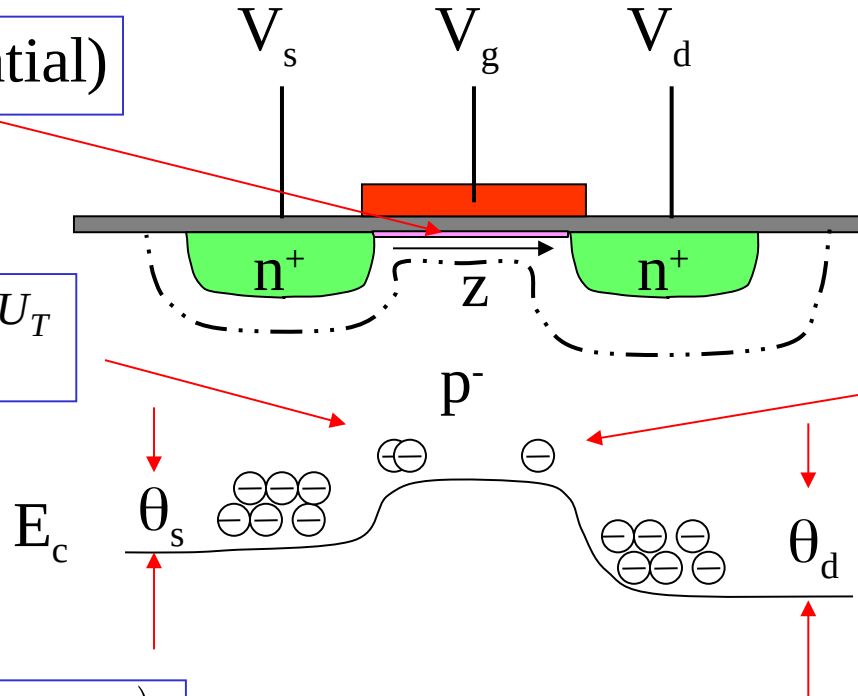
Concentration
gradient

N=carrier density
D=diffusion constant

Subthreshold nFET: Current is diffusion current

ψ_s (surface potential)

$$N_s = N_o e^{-\theta_s / U_T}$$



$$N_d = N_o e^{-\theta_d / U_T}$$

$$\theta_s = \theta_0 - q(\psi_s - V_s)$$

$$\theta_d = \theta_0 - q(\psi_s - V_d)$$

$$\frac{dN}{dz} = \frac{N_s - N_d}{L}$$

$$I = -qWD_n \frac{dN}{dz} = I_0 e^{\psi_s / U_T} (e^{-V_d / U_T} - e^{-V_s / U_T})$$

N =carrier density per unit volume

W =channel width

L =channel length

D =diffusion constant

θ_0 =built-in voltage

Fwd

Rev

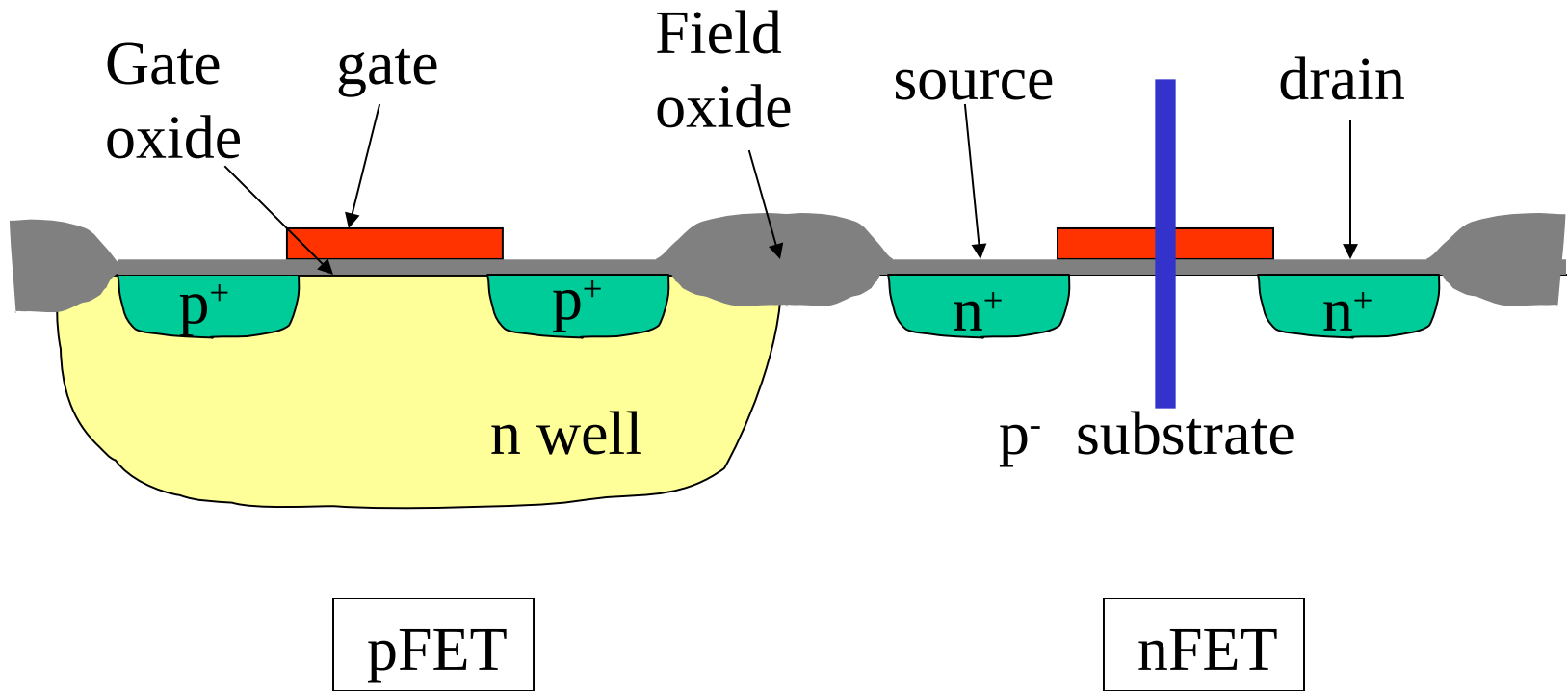
We have equation for subthreshold current, but we don't directly control the surface potential

$$I = -qWD_n \frac{dN}{dz} = I_0 e^{\psi_s / U_T} (e^{-V_d / U_T} - e^{-V_s / U_T})$$

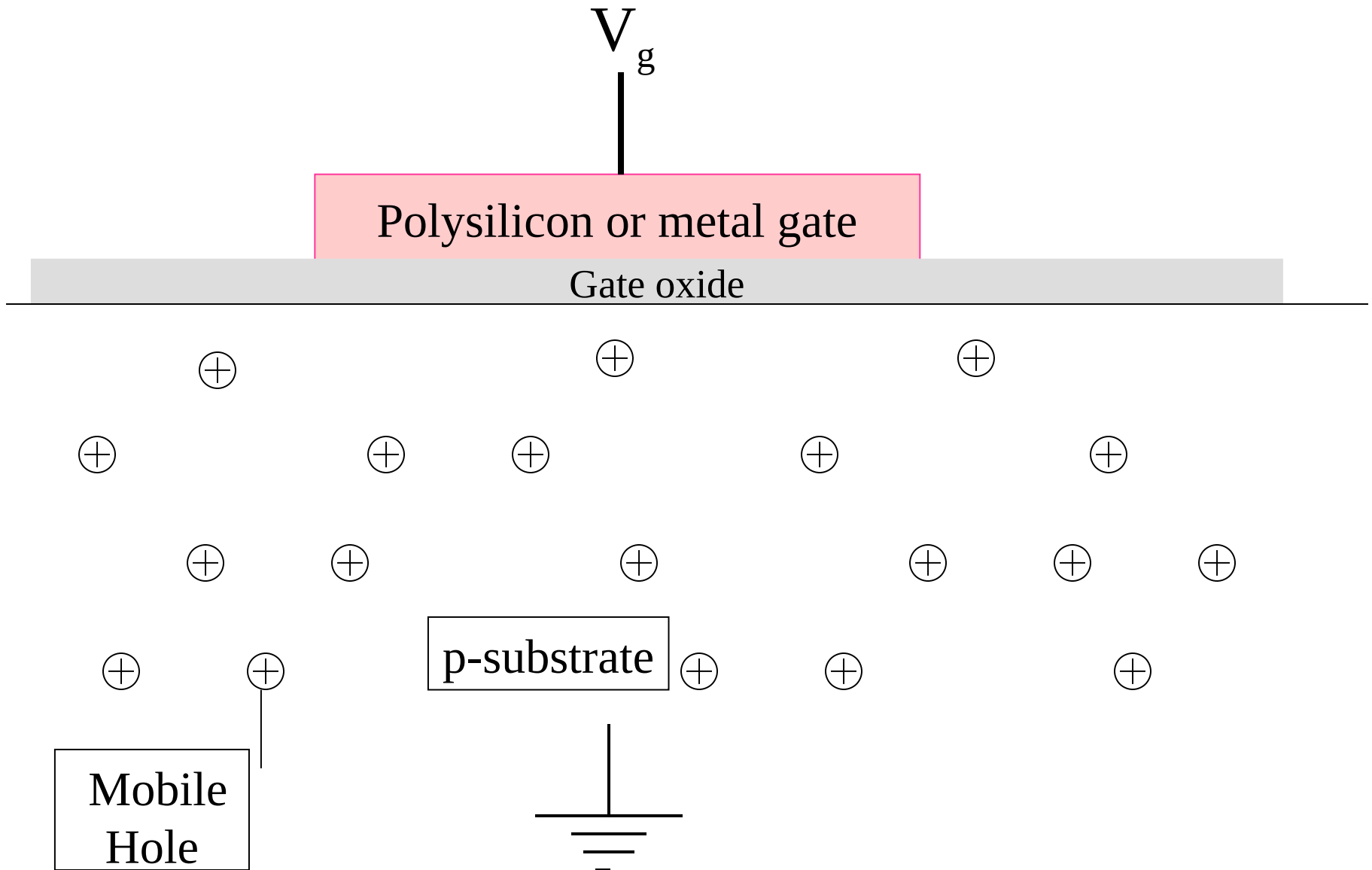


How is the surface potential related to the gate voltage?

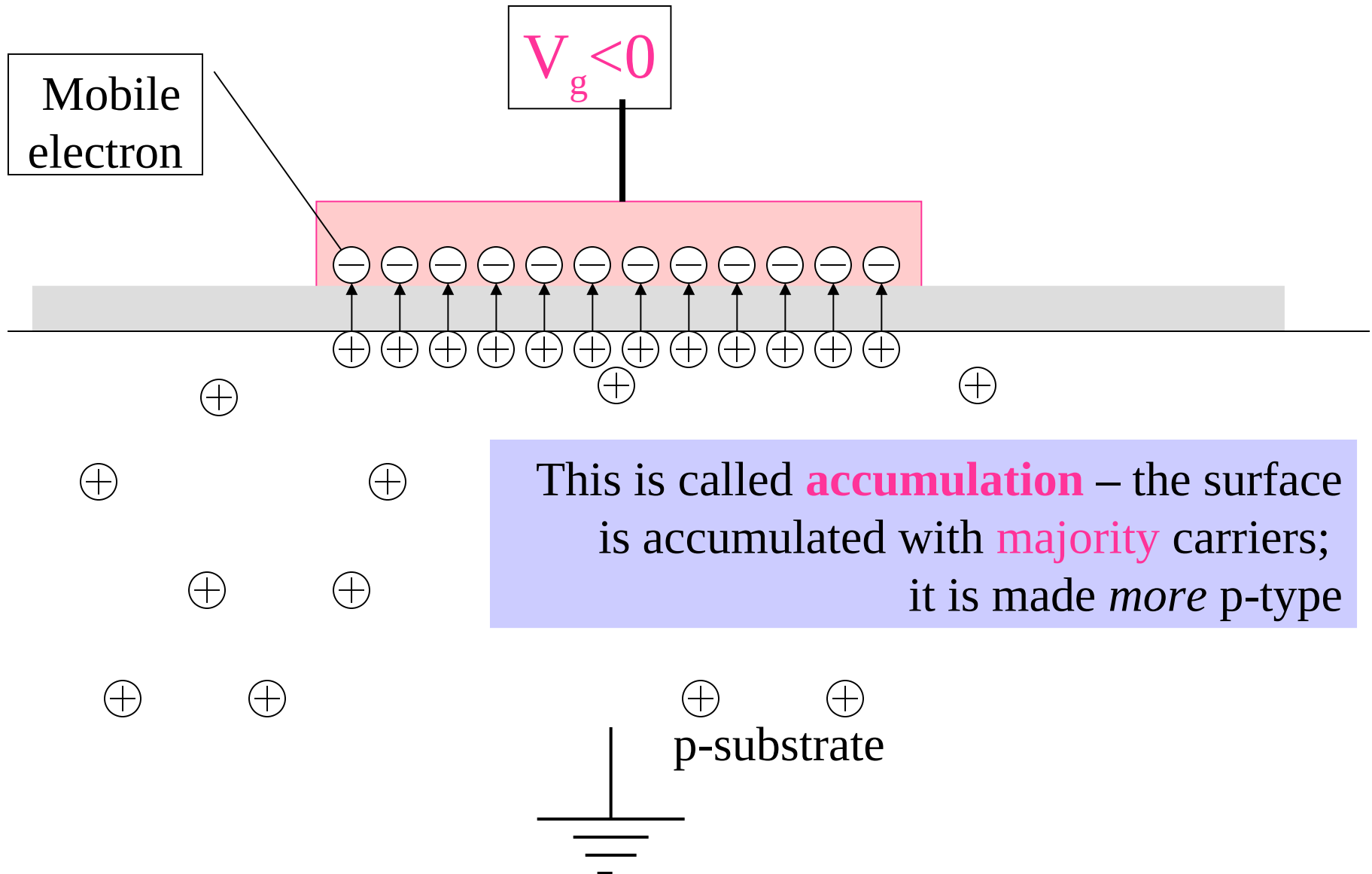
We need to understand effect of gate on surface potential



MOS capacitor structure

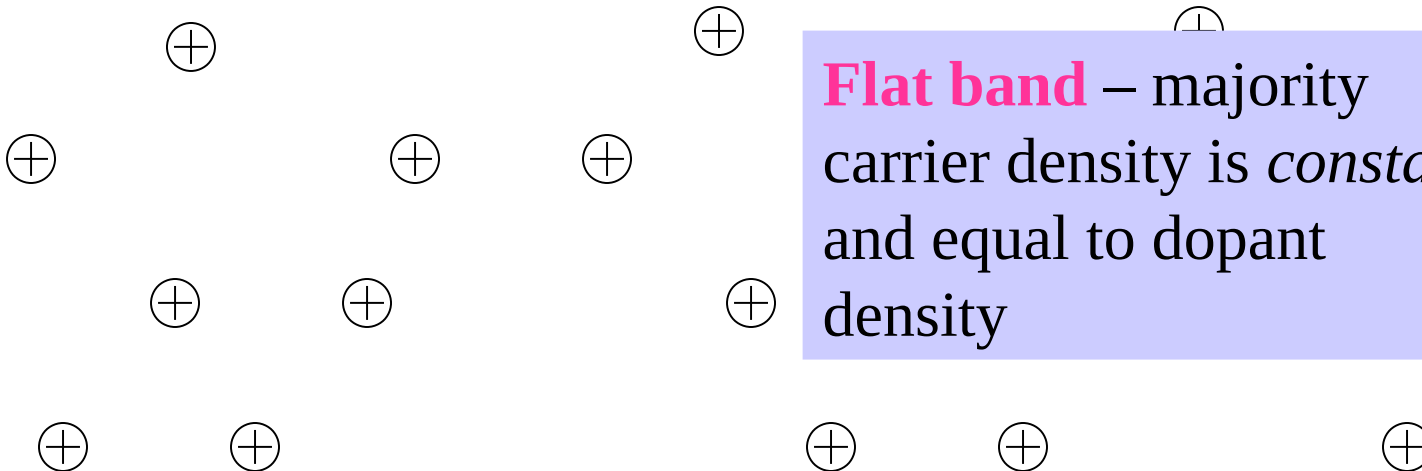


MOS capacitor structure: accumulation

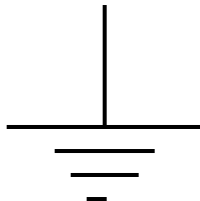


MOS capacitor structure: flat band

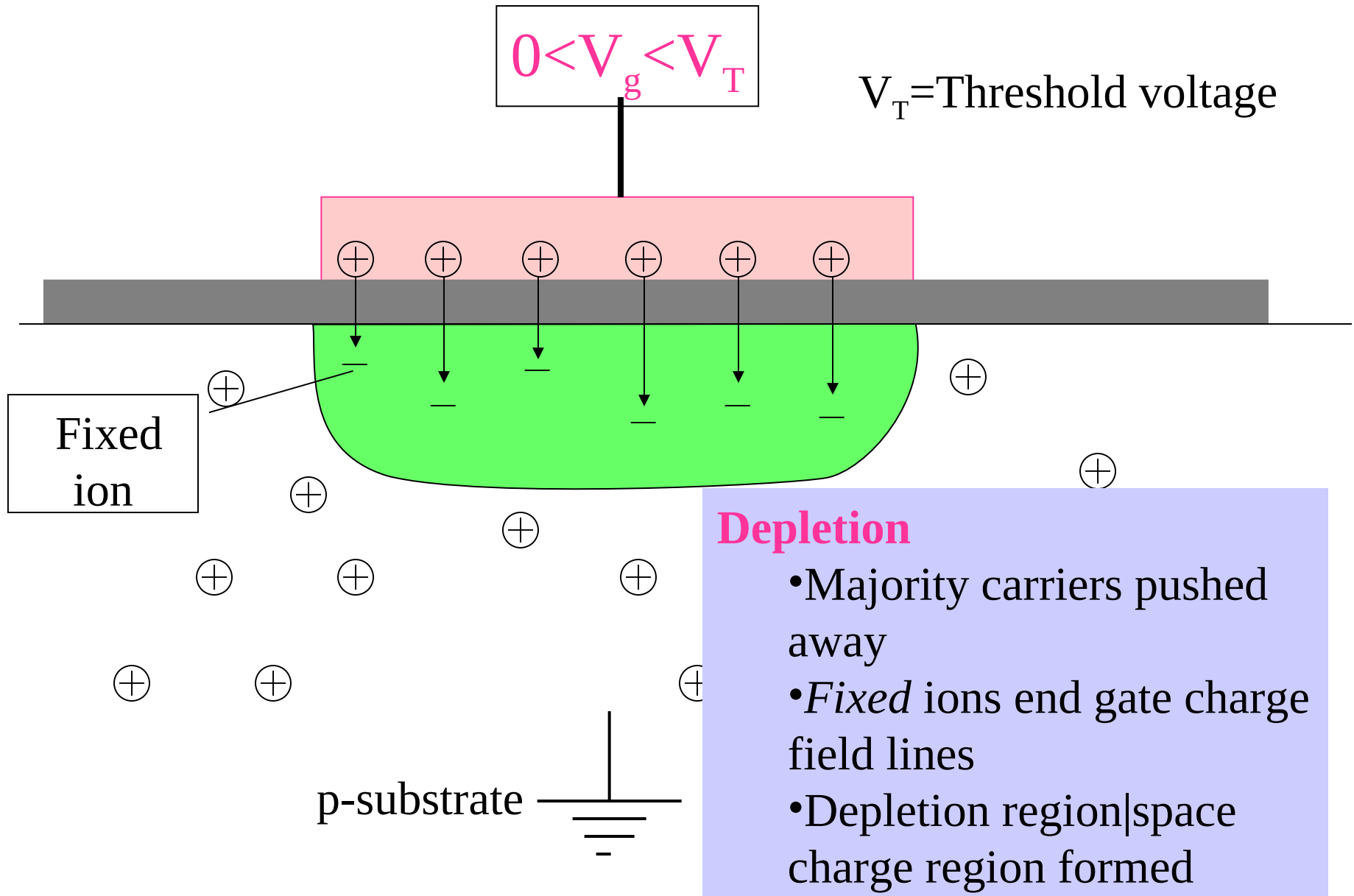
$$V_g = V_{fb} \sim 0$$



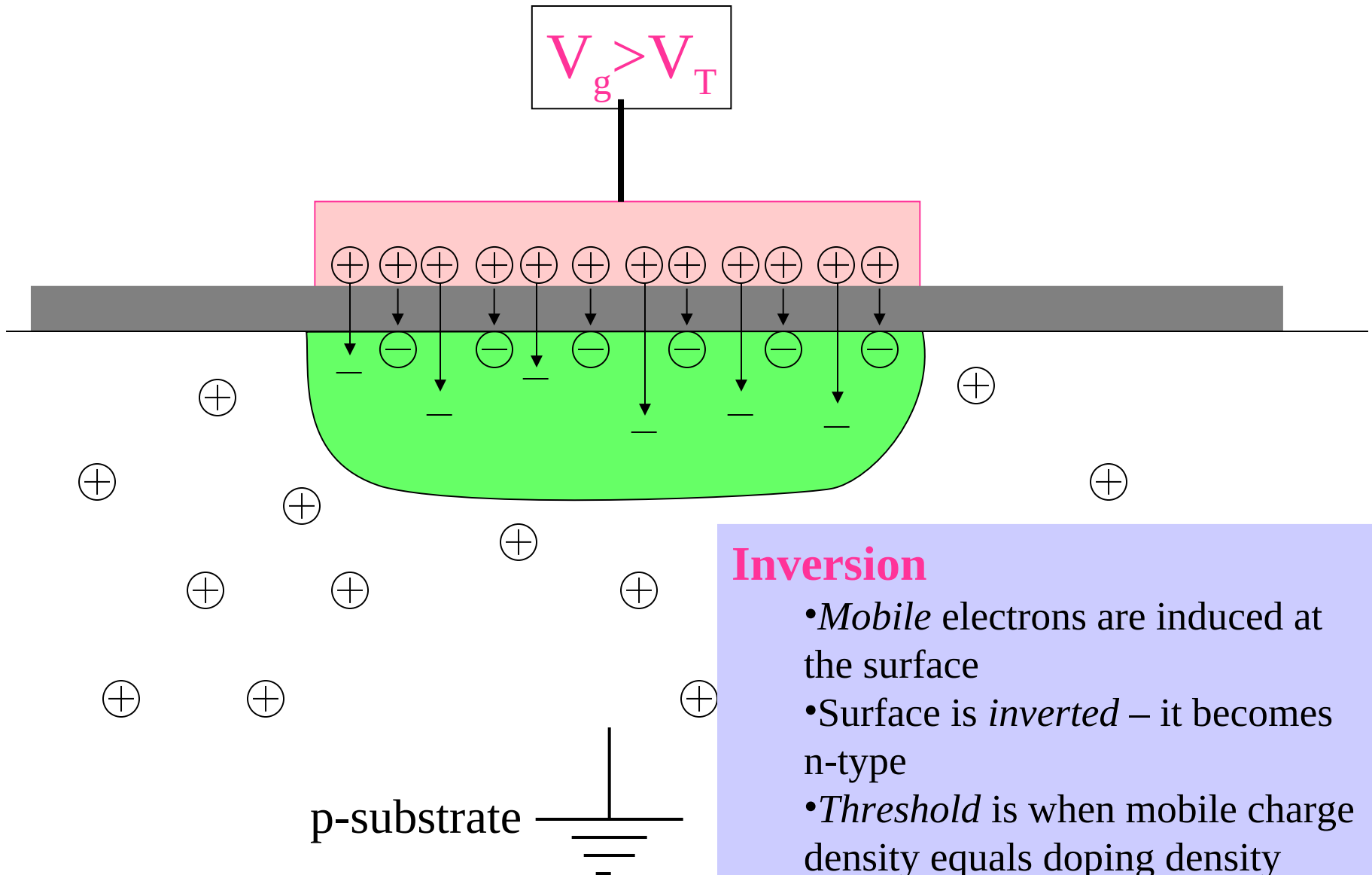
Flat band – majority carrier density is *constant* and equal to dopant density



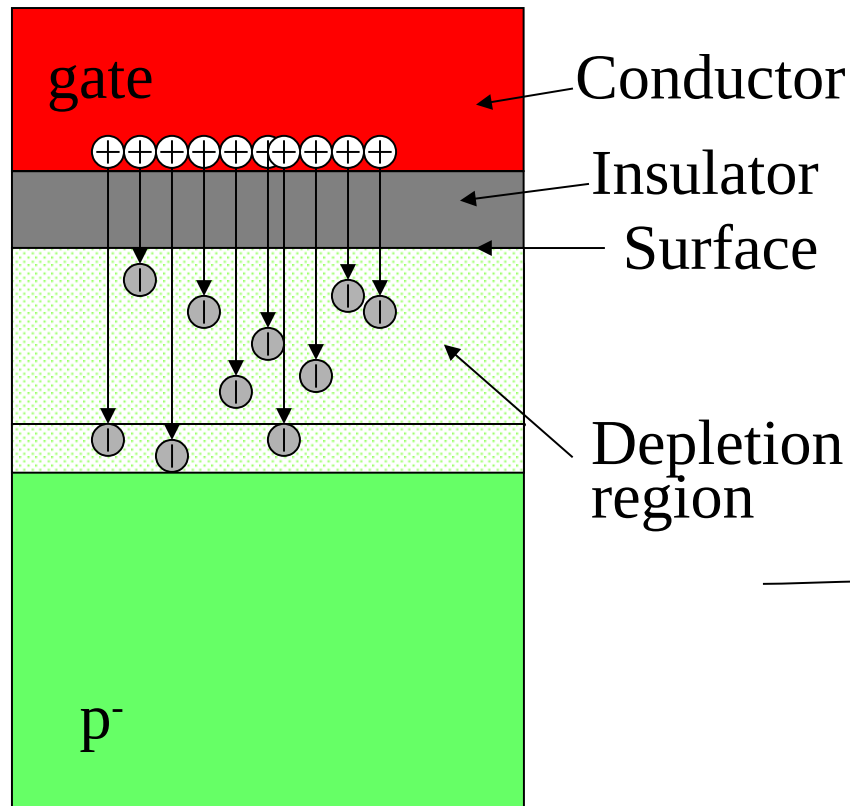
MOS capacitor structure: depletion



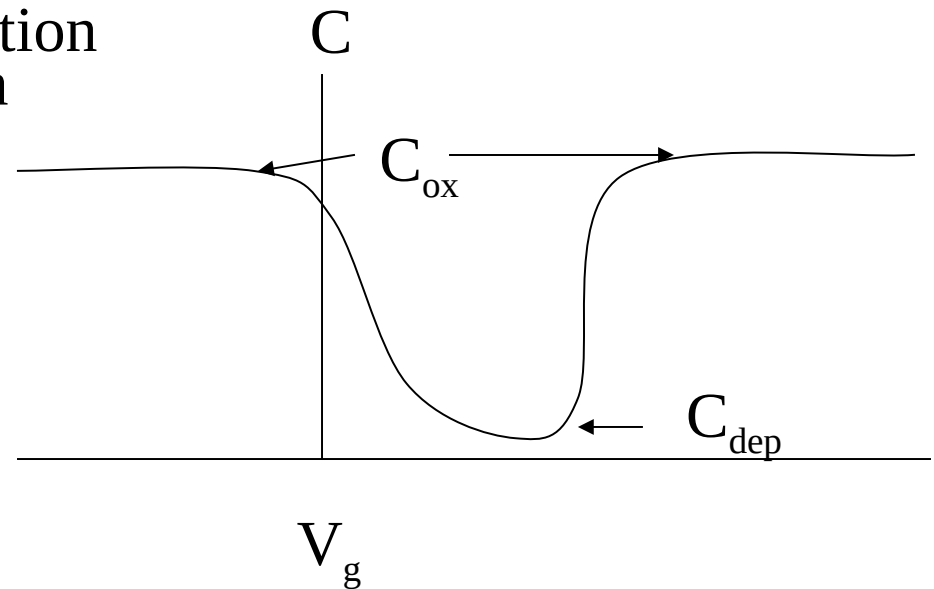
MOS capacitor structure: inversion



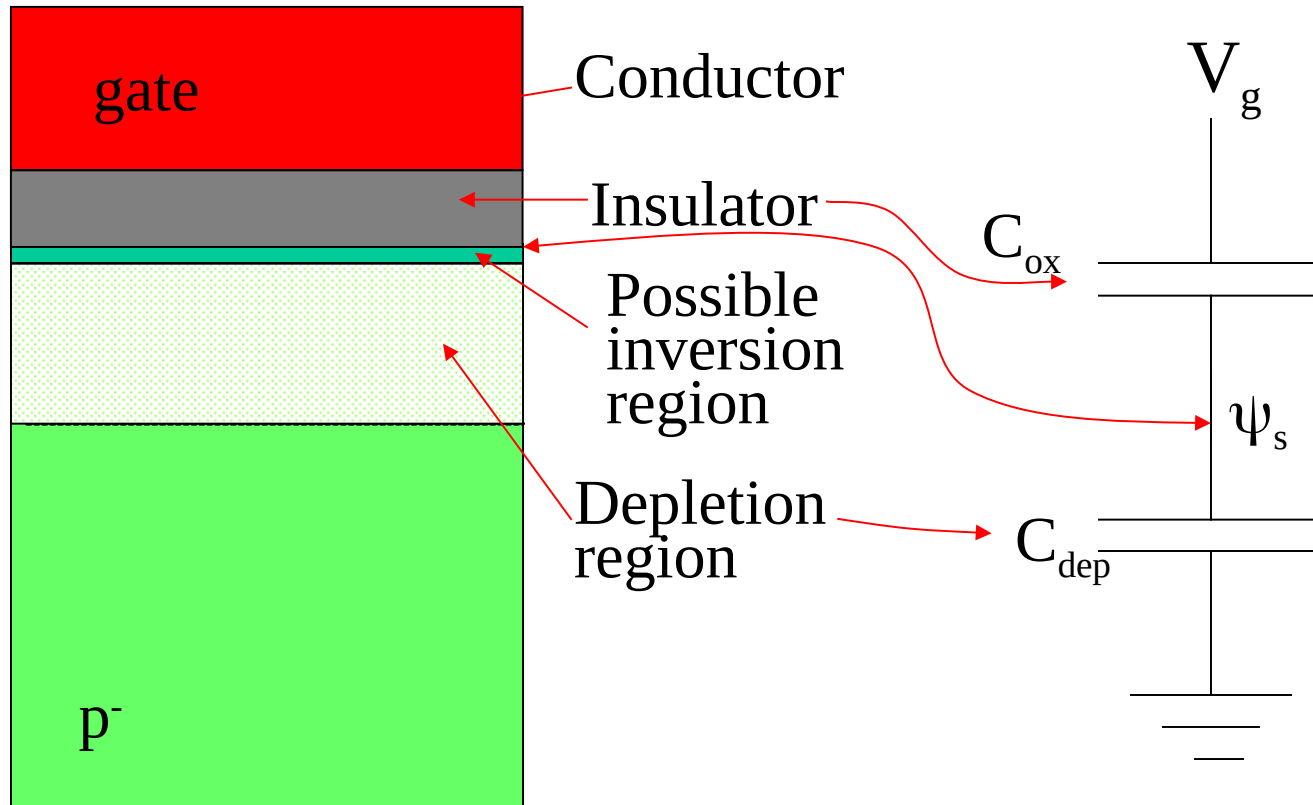
What is a *depletion capacitor*?



$$C = \frac{dQ}{dV}$$



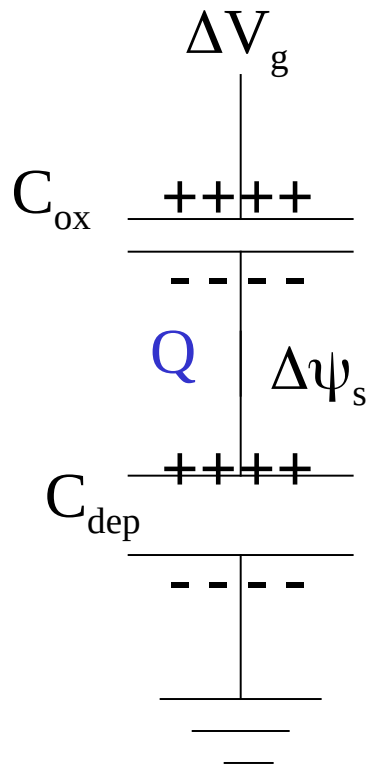
Influence of gate on surface potential



ψ_s = Surface potential

$$\kappa(kappa) = \frac{\partial \psi_s}{\partial V_g} = \frac{C_{ox}}{C_{ox} + C_{dep}}$$

Gate-depletion capacitive divider



How does changing V_g change ψ_s ?

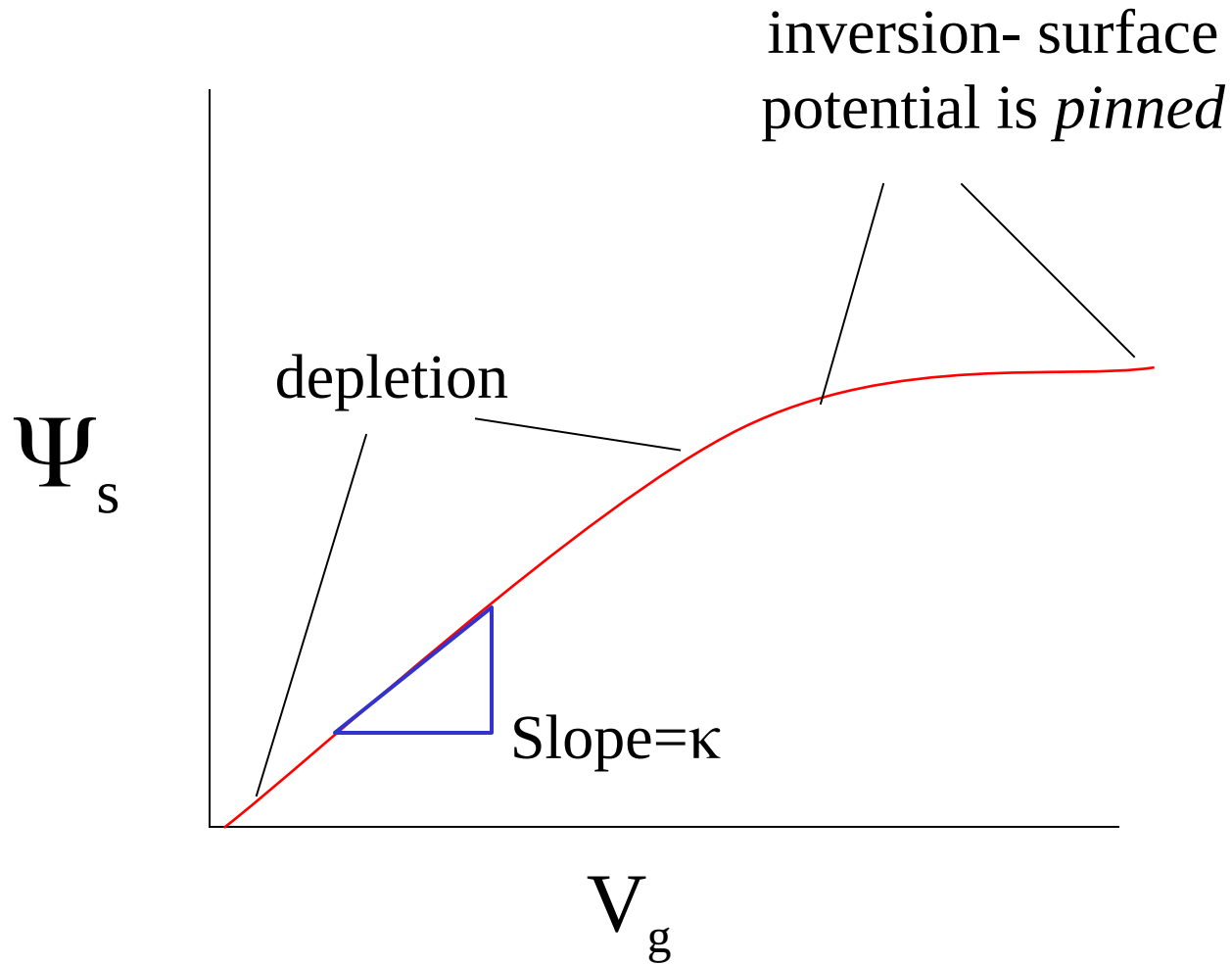
1. $CV=Q$
2. Charge Q on ψ_s is constant
3. Change V , hold Q constant

$$C_{ox}(\Delta V_g - \Delta\psi_s) = C_{dep}\Delta\psi_s$$

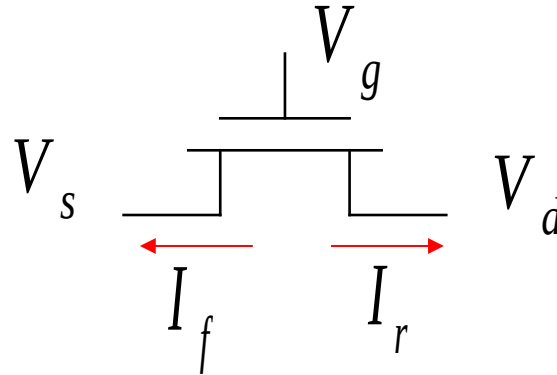
$$C_{ox}\Delta V_g = (C_{ox} + C_{dep})\Delta\psi_s$$

$$\frac{\Delta\psi_s}{\Delta V_g} = \frac{C_{ox}}{C_{ox} + C_{dep}} \equiv K$$

Surface potential as function of V_g



Equations for Subthreshold nFET



$$I = I_0 e^{\kappa V_g / U_T} (e^{-V_s / U_T} - e^{-V_d / U_T})$$
$$= I_f - I_r$$

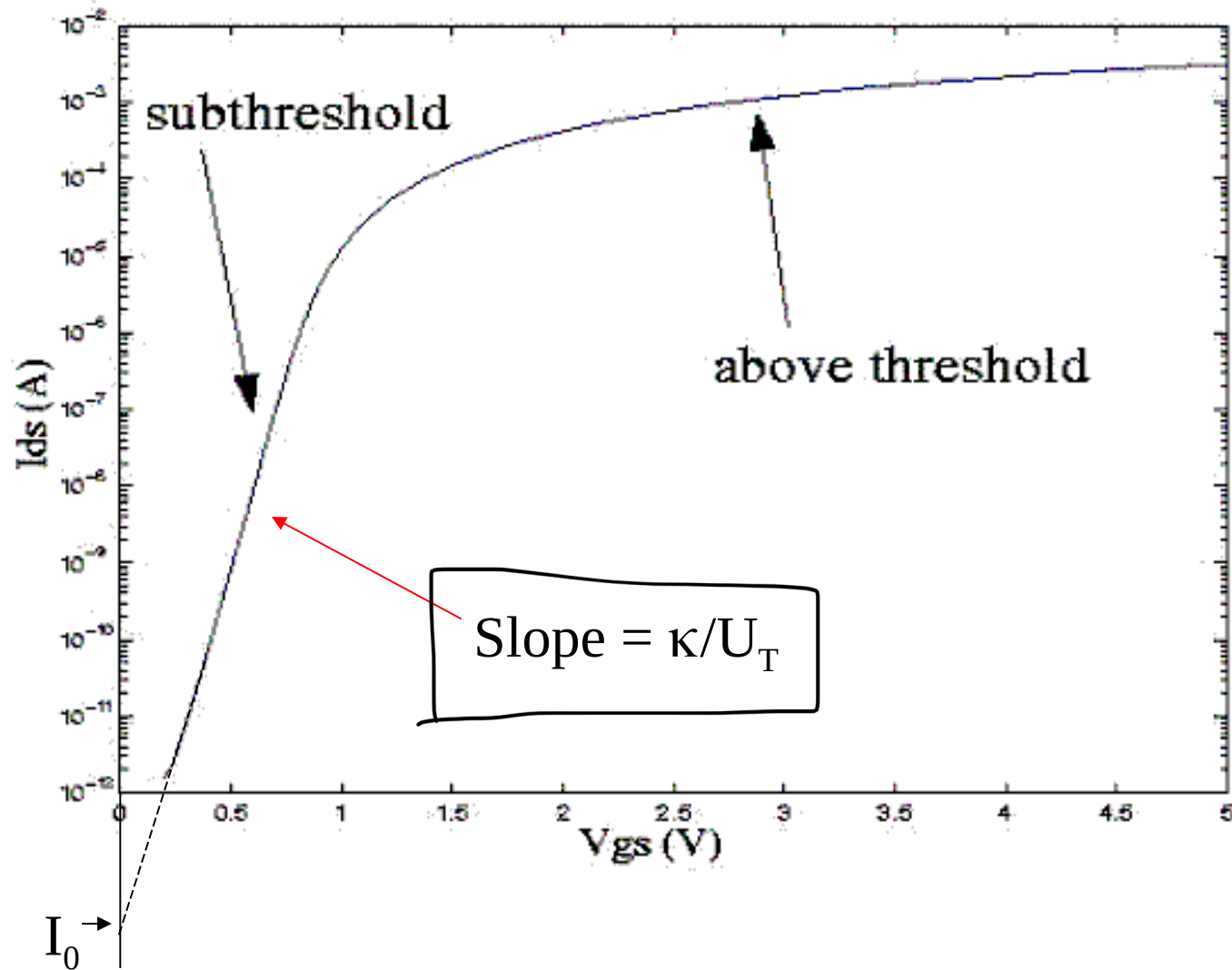
I_f = forward current

I_r = reverse current

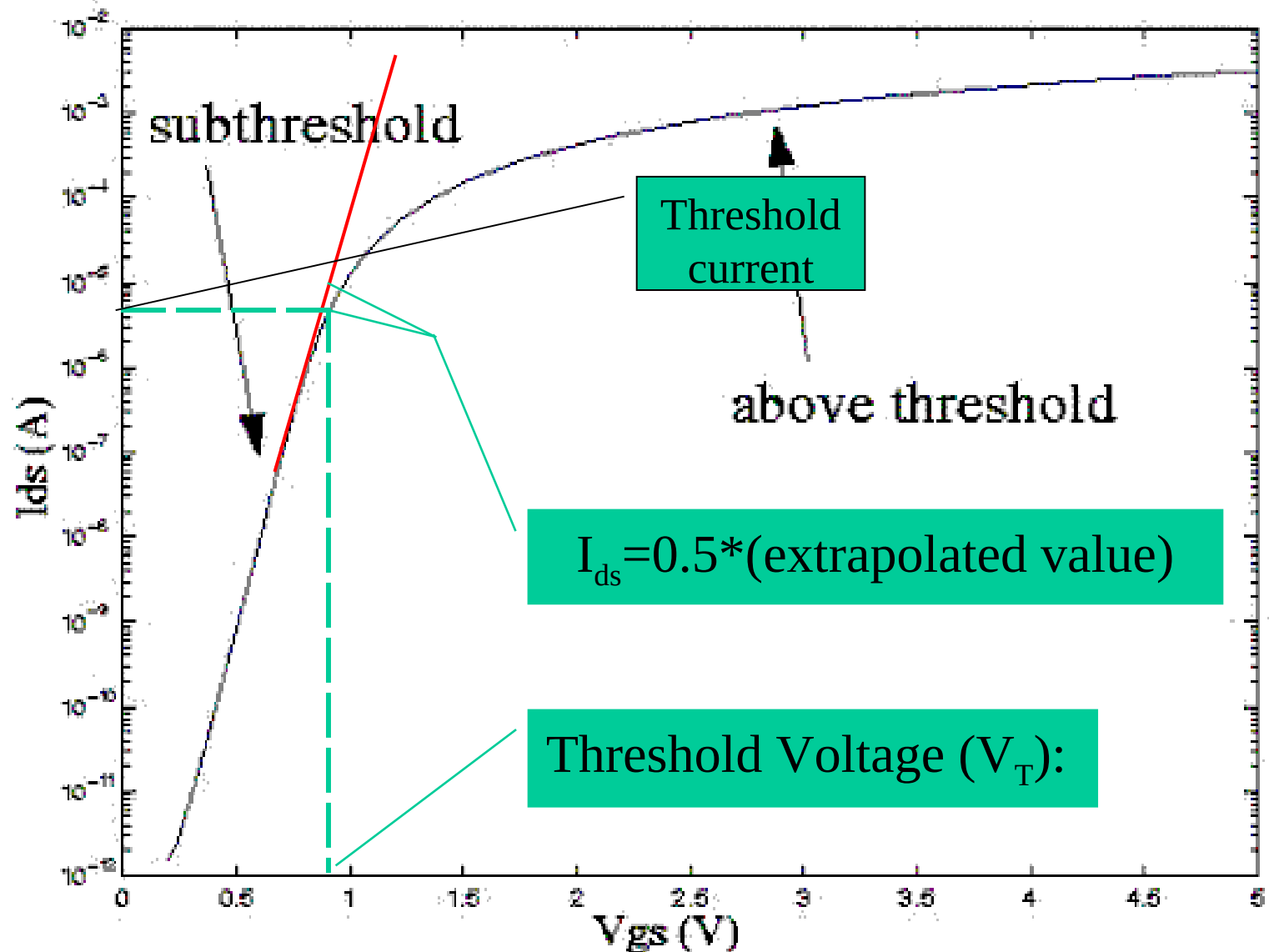
$$I_f = I_0 e^{\kappa V_g / U_T} e^{-V_s / U_T}$$

$$I_r = I_0 e^{\kappa V_g / U_T} e^{-V_d / U_T}$$

nFET curve: I vs V_{gs}



nFet Threshold



Regimes of Subthreshold Operation (dependence on V_{ds})

Triode/Linear Region

$$I = I_0 e^{(\kappa V_g - V_s)/U_T} \left(1 - e^{-(V_d - V_s)/U_T} \right)$$

Saturation Region

$$I = I_f = I_0 e^{(\kappa V_g - V_s)/U_T}$$

nFET subthreshold Operation

V in units of U_T

Triode/Linear Region

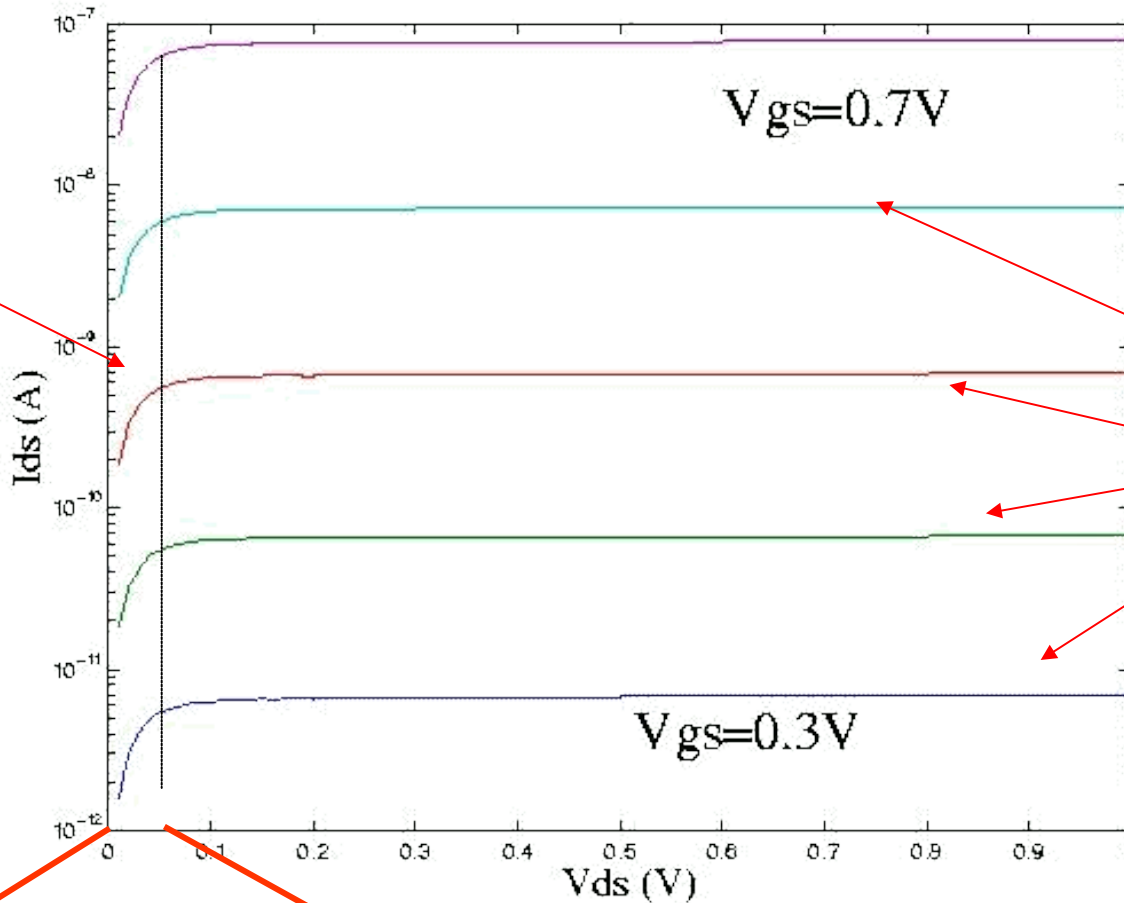
$$I = I_0 e^{kV_g - V_s} (1 - e^{-V_{ds}})$$

Saturation Region, $V_{ds} > \text{a few } U_T$

$$I = I_f = I_0 e^{kV_g - V_s}$$

nFET drain curve: I_{ds} vs V_{ds}

Ohmic
region



Saturation
region

$$\frac{4kT}{q} \approx 100 \text{ mV}$$

What about the pre-exponential I_0 ?

$$I = I_f = I_0 e^{(kV_g - V_s)/U_T}$$

- I_0 comes from the built-in barrier and the doping concentrations. It takes the form

$$I_0 = N_s U_T^2 \beta(T) \exp\left(\frac{-kV_T}{U_T}\right)$$

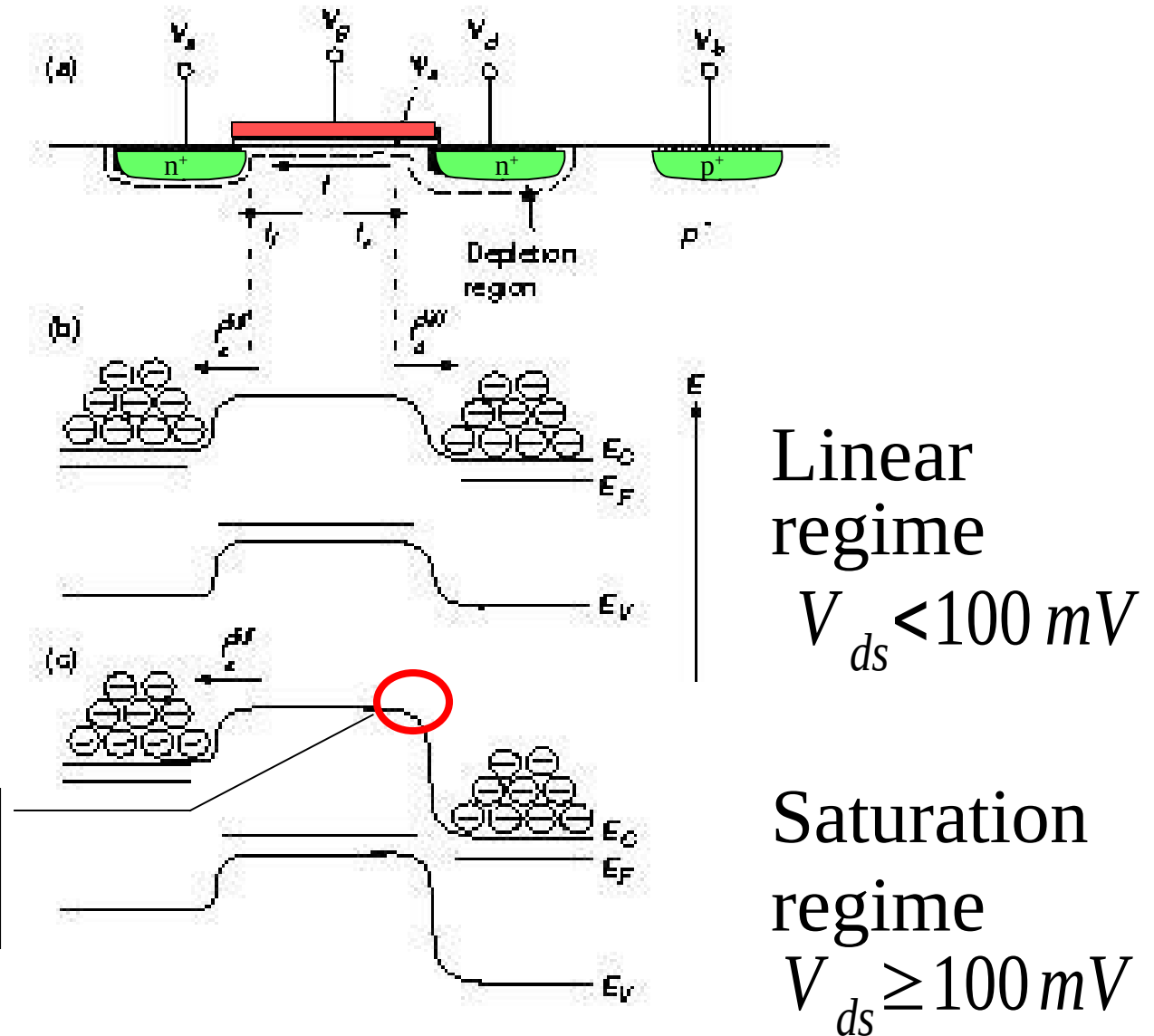
Dimensionless source concentration

$U_T \beta$: diffusivity

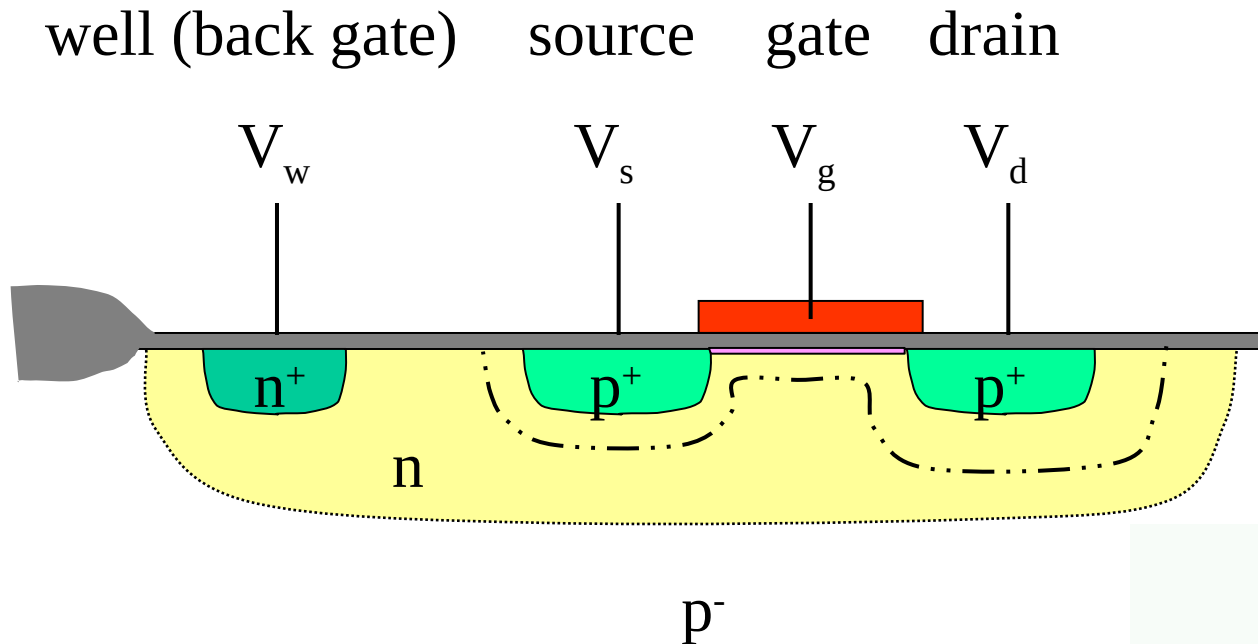
U_T : factor for density of states

Concentration at source reduced by barrier

Band Diagram for subthreshold nFET



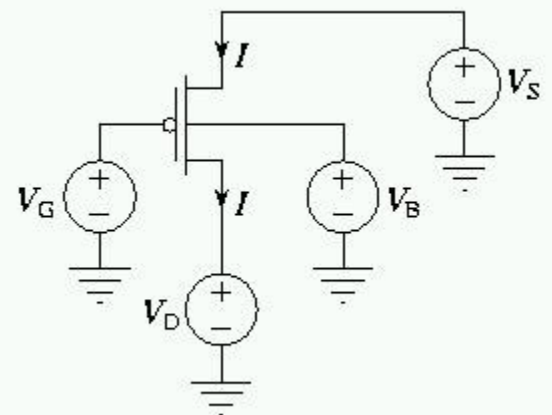
p-type MOSFET



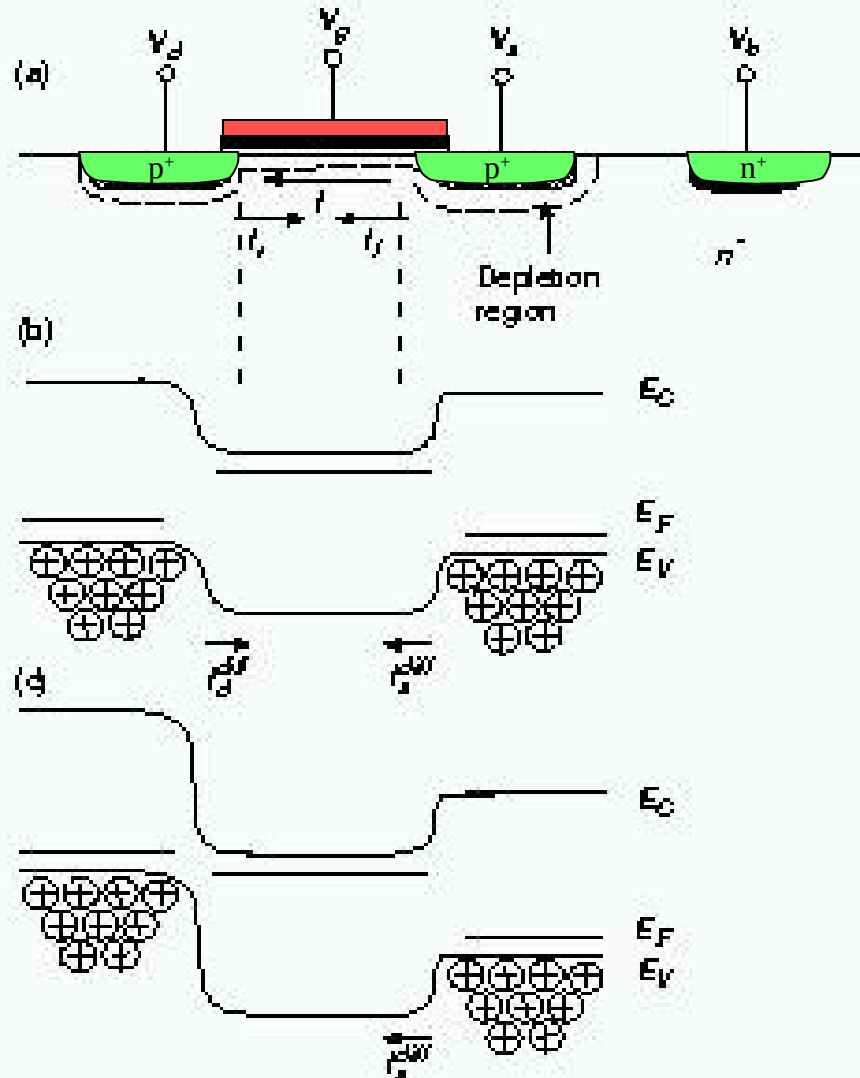
$$V_g, V_d, V_s \leq V_w$$

$$V_s \geq V_d$$

All voltages are referenced to $V_w = V_{dd}$



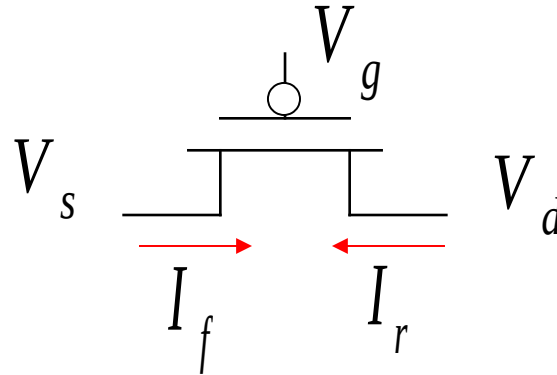
Band Diagram for subthreshold pFET



Linear
regime
 $V_{ds} < 100 \text{ mV}$

Saturation
regime
 $V_{ds} \geq 100 \text{ mV}$

Equations for Subthreshold pFET



$$I = I_0 e^{-\kappa V_g / U_T} (e^{V_s / U_T} - e^{V_d / U_T})$$
$$= I_f - I_r$$

I_f = forward current

I_r = reverse current

$$I_f = I_0 e^{-\kappa V_g / U_T} e^{V_s / U_T}$$

$$I_r = I_0 e^{-\kappa V_g / U_T} e^{V_d / U_T}$$

pFET subthreshold Operation

V in units of U_T

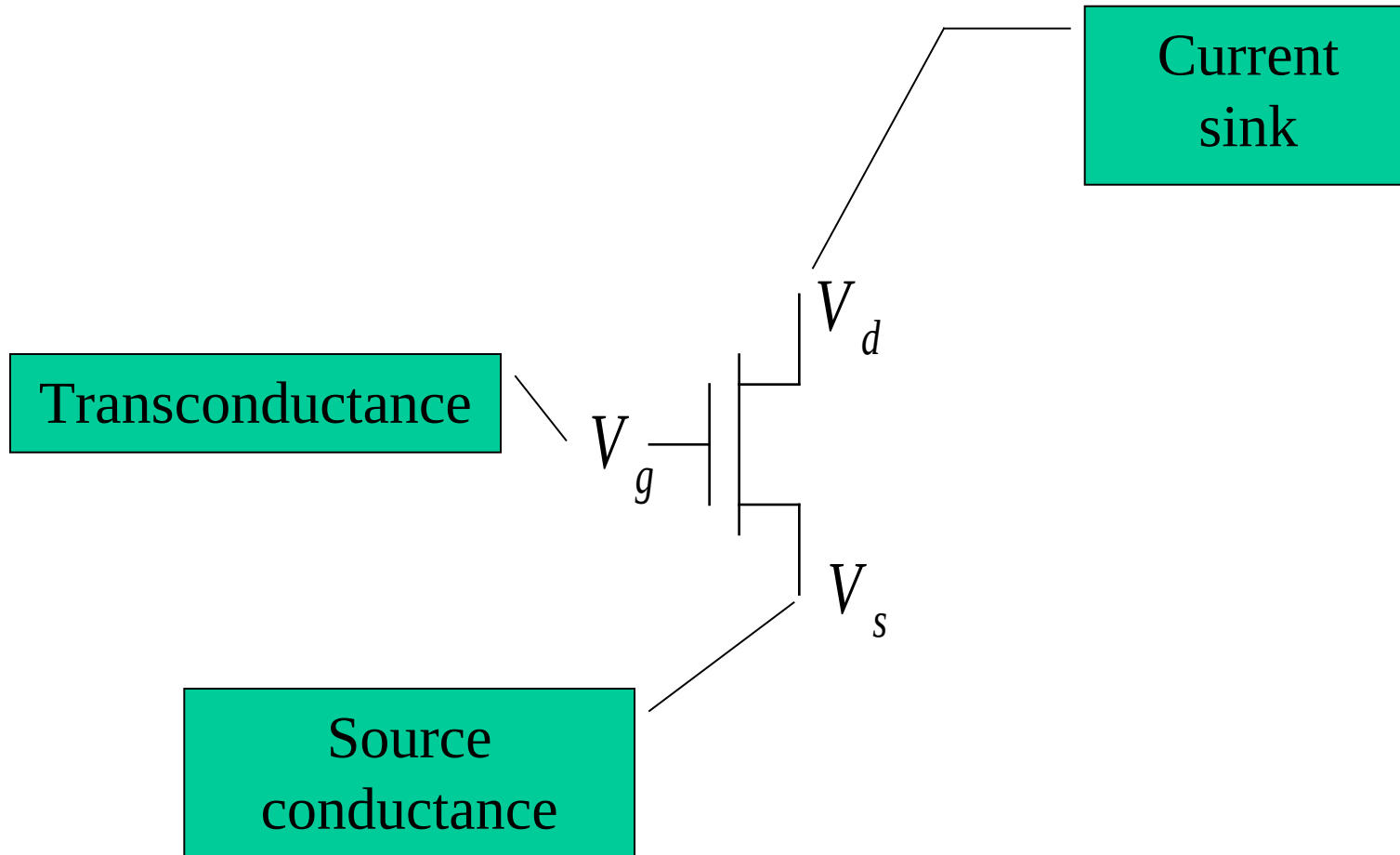
Triode/Linear Region

$$I = I_0 e^{-\kappa V_g + V_s} (1 - e^{+V_{ds}})$$

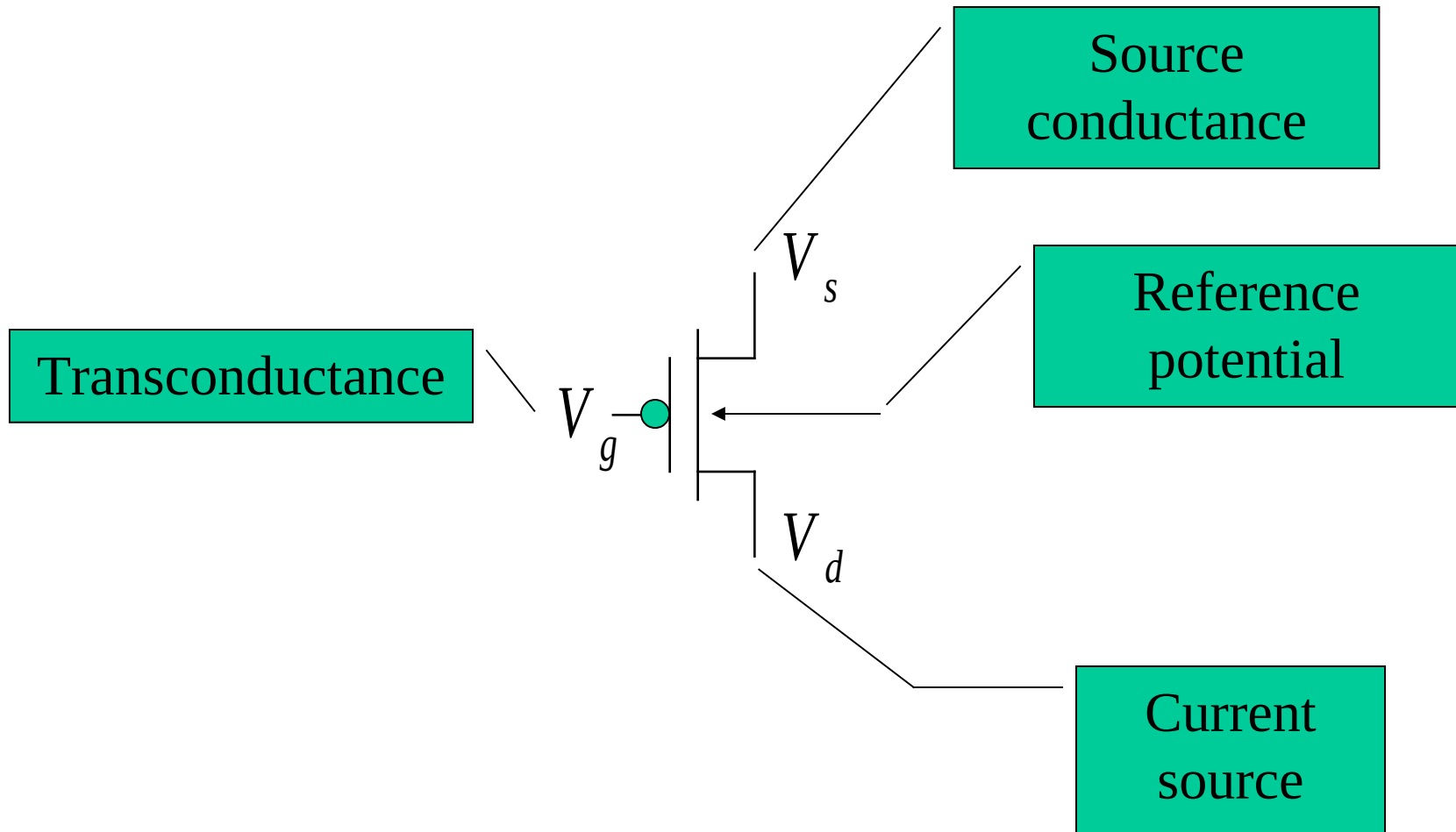
Saturation Region, $V_{ds} > \text{a few } U_T$

$$I = I_f = I_0 e^{-\kappa V_g + V_s}$$

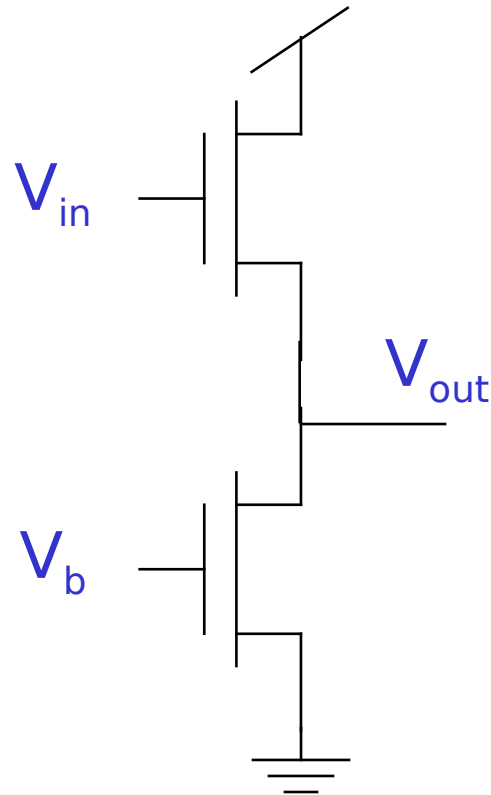
nFET functional behavior



pFET functional behavior



Circuit question



- What is V_{out} vs. V_{in} ?
- Why is this circuit called a *source follower*?
- How can you use this circuit to measure κ ?

THE END

Next week:

What is the transistor threshold?

Above threshold operation.

Drain conductance-Early effect

